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(54) **METHODS AND APPARATUS FOR MITIGATING HYSTERESIS IMPACT ON CURRENT SENSING ACCURACY FOR AN ELECTRONIC DISPLAY**

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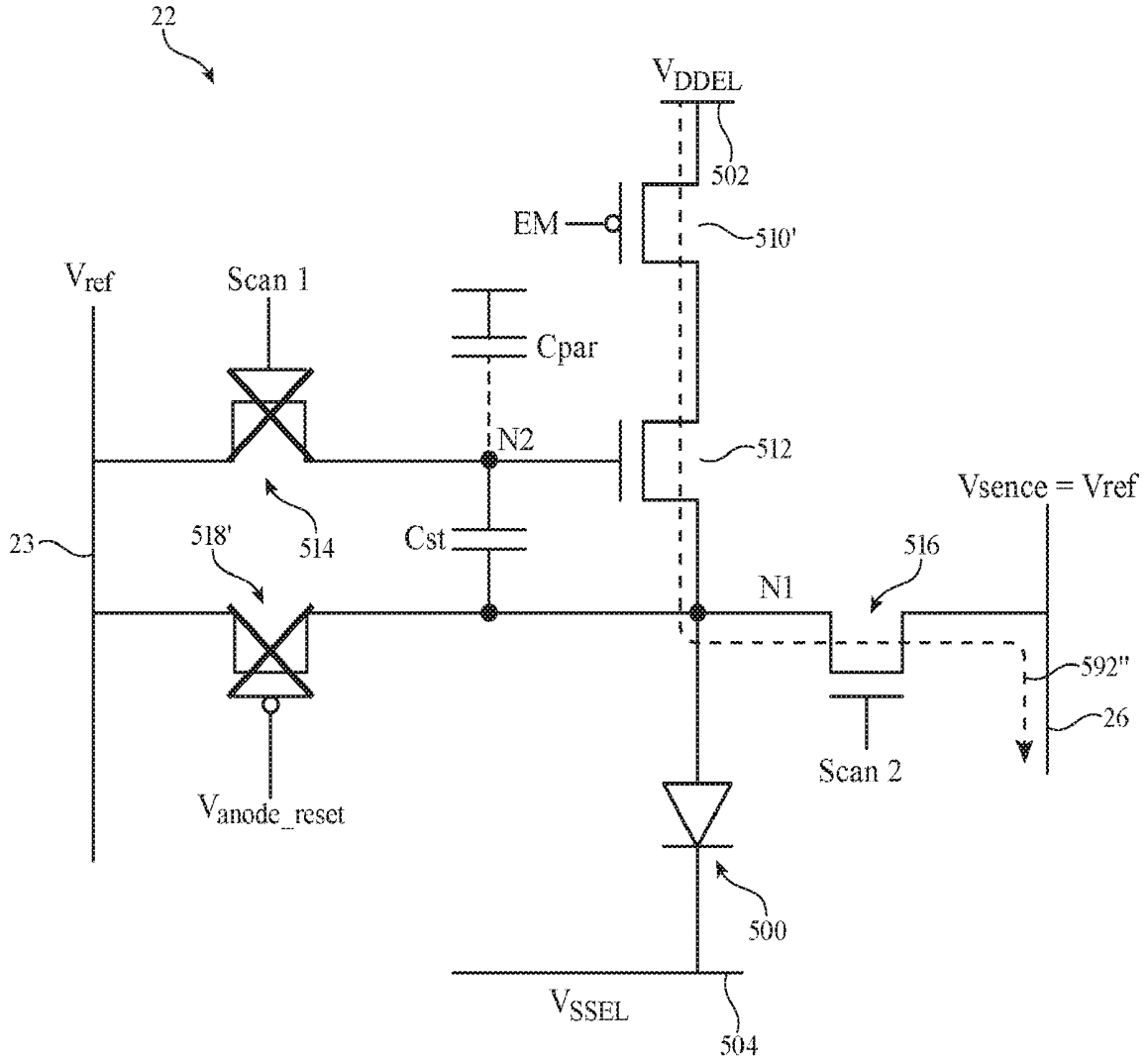
(57) **ABSTRACT**

A display may include an array of organic light-emitting diode display pixels having transistors characterized by threshold voltages subject to transistor variations. Compensation circuitry may be used to sense a current from selected display pixels. A display pixel may include a drive transistor, a gate setting transistor for driving a reference voltage onto the gate terminal of the drive transistor, a data loading and current sensing transistor for connecting the drive transistor to a data/current-sensing line, a light-emitting diode, an emission control transistor coupled between the drive transistor and the diode, and an anode resetting transistor for selectively resetting the anode terminal of the diode. During pixel conditioning and current sensing operations, the anode resetting transistor may be constantly turned on to ensure that there is no voltage perturbation at the source terminal of the drive transistor, which can help prevent hysteresis-induced current sensing error.



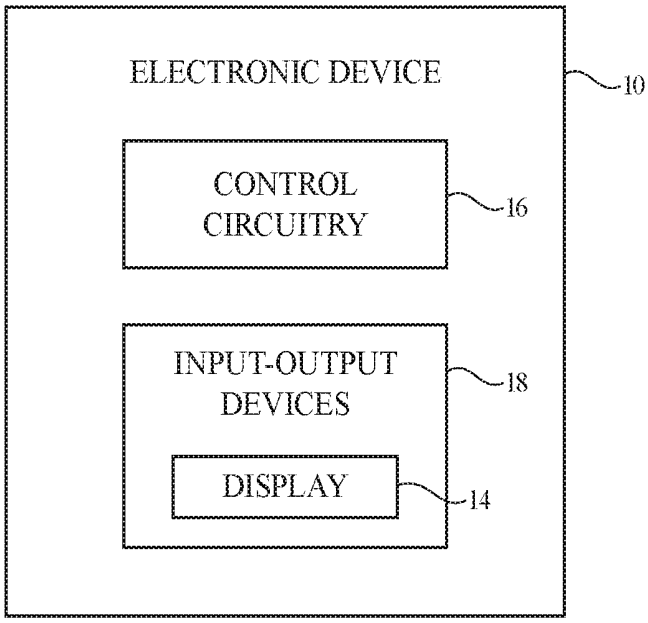

ELECTRONIC DEVICE
10
CONTROL CIRCUITRY
16
INPUT-OUTPUT DEVICES
18
DISPLAY
14

FIG. 1

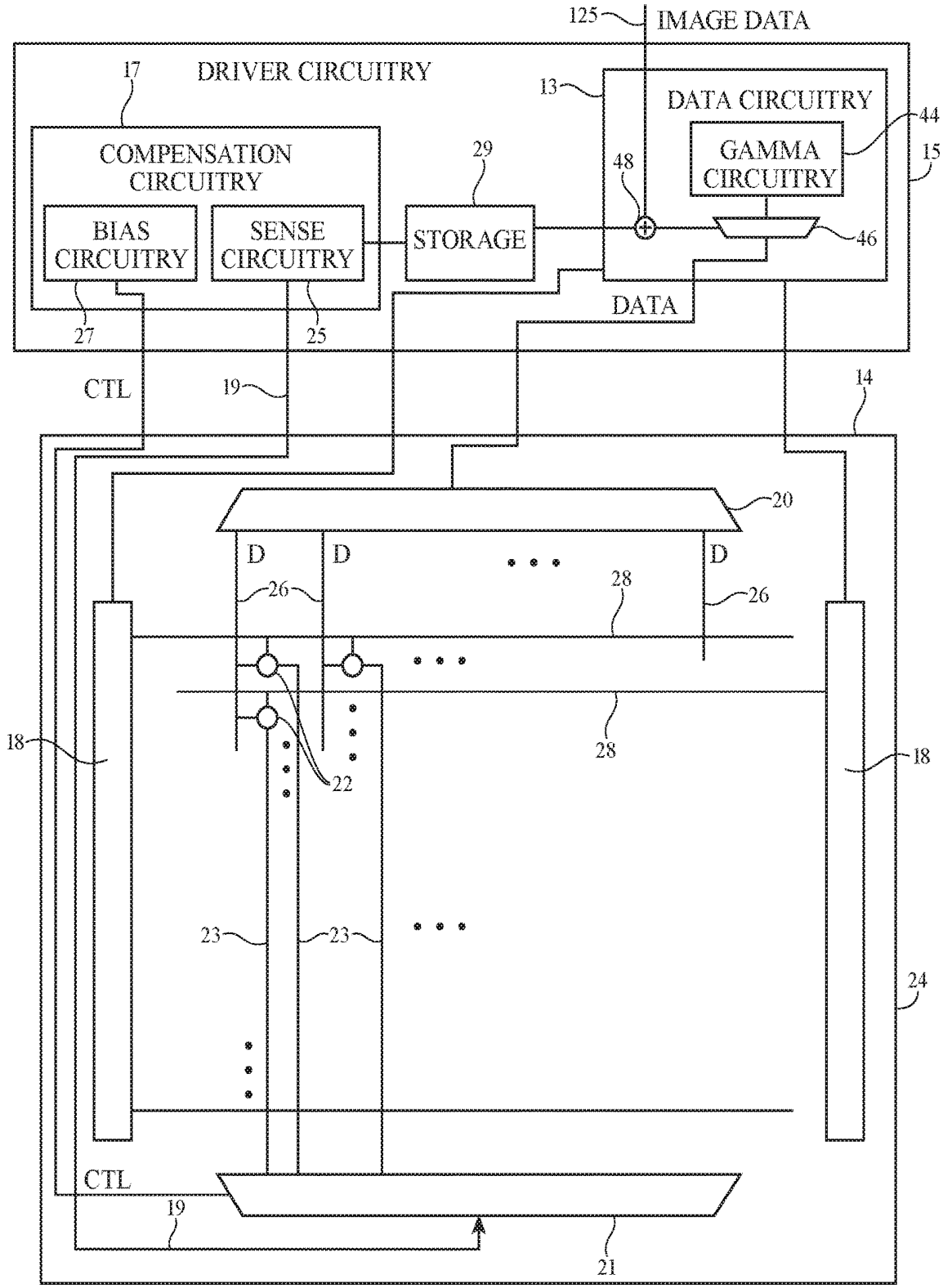

125
IMAGE DATA
17
DRIVER CIRCUITRY
13
DATA CIRCUITRY
44
GAMMA CIRCUITRY
15
COMPENSATION CIRCUITRY
29
48
BIAS CIRCUITRY
SENSE CIRCUITRY
STORAGE
46
DATA
27
25
CTL
19
14
20
D
D
D
26
28
26
18
22
28
18
23
23
24
CTL
19
21

FIG. 2

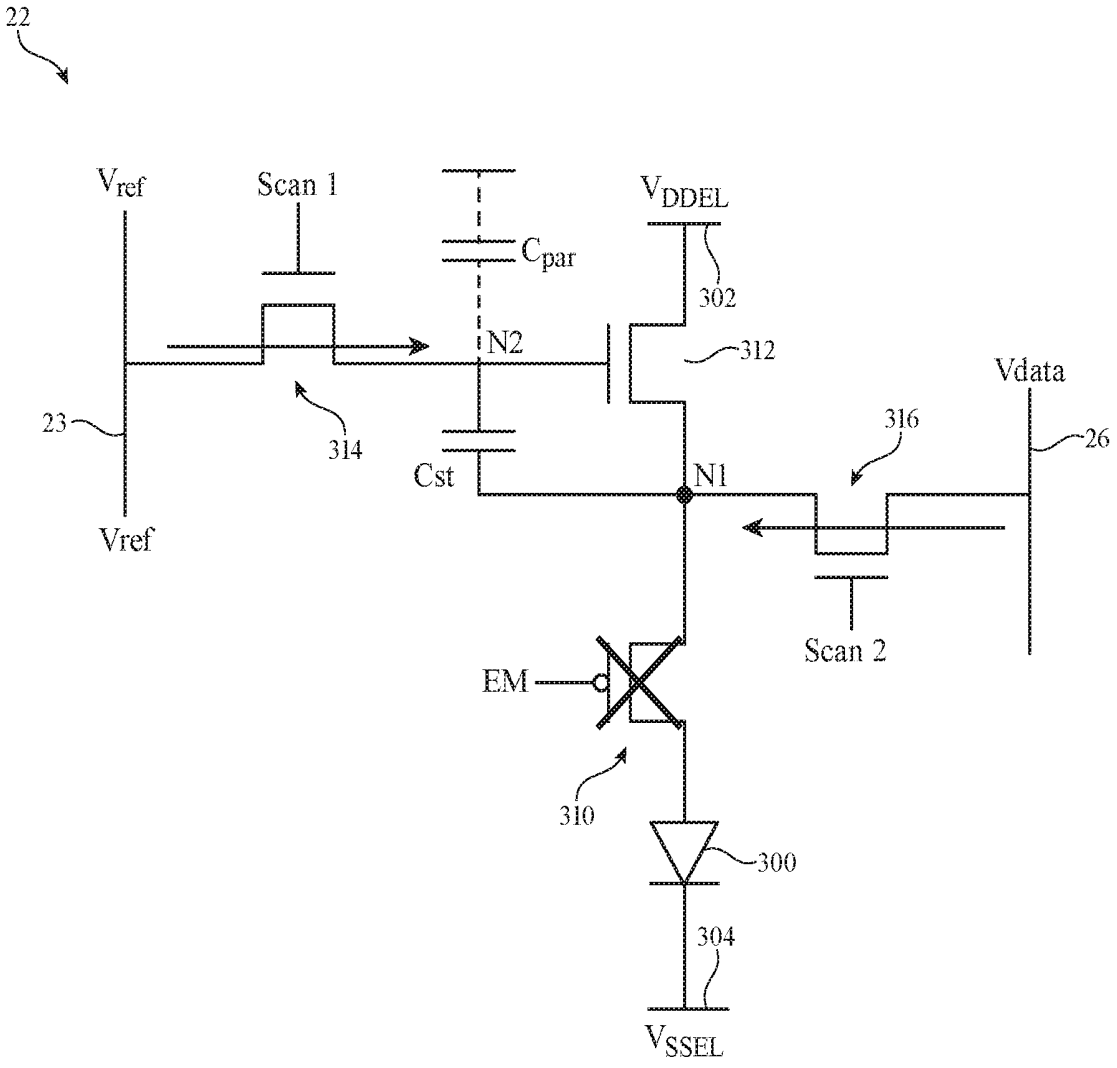

22
Vref
Scan 1
Cpar
VDDEL
302
N2
312
Vdata
316
23
314
Cst
N1
26
Vref
Scan 2
EM
310
300
304
VSSEL

FIG. 3A

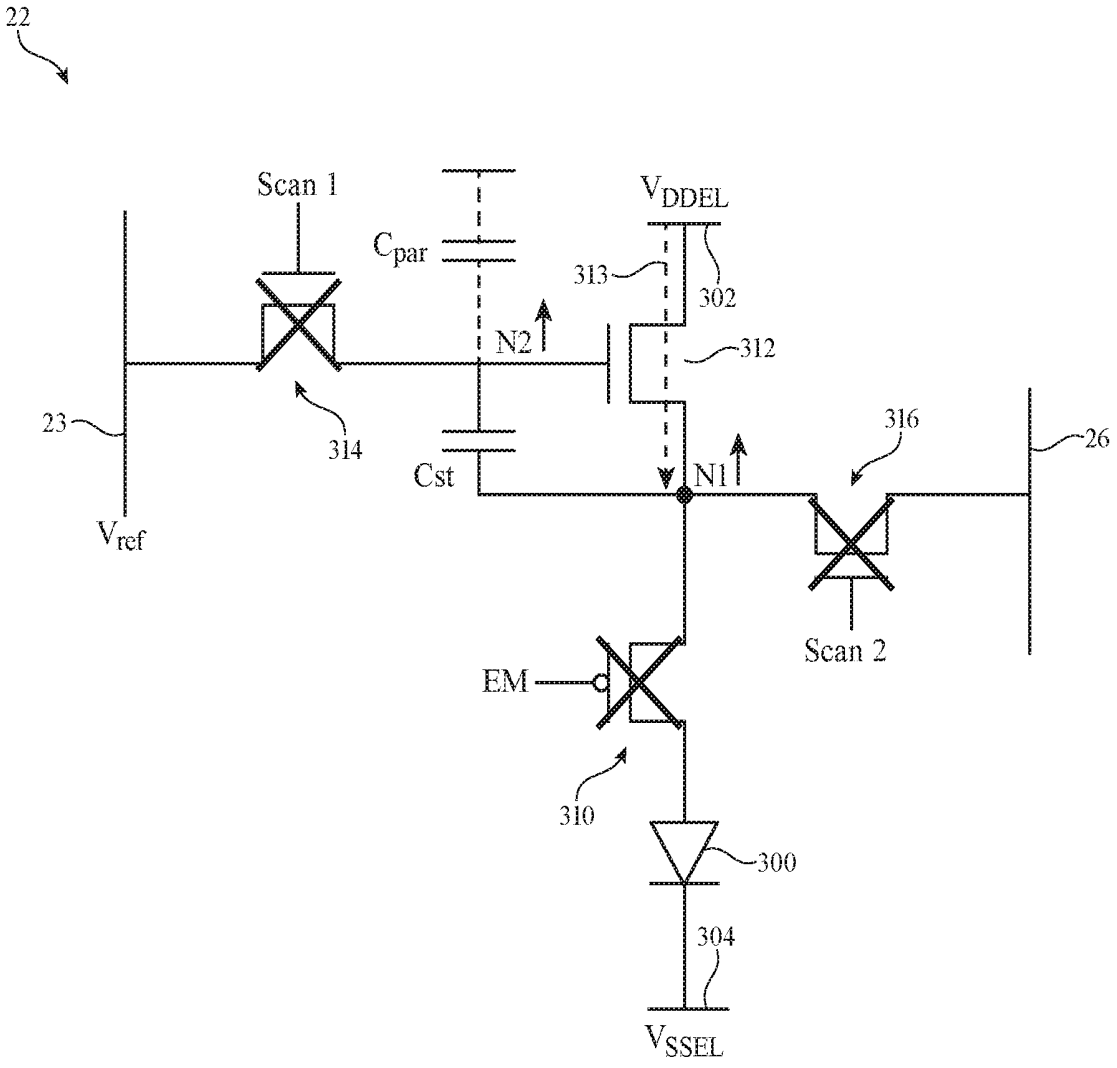

22
Scan 1
C_{par}
V_{DDEL}
313
302
N2
312
23
314
316
26
Cst
N1
V_{ref}
Scan 2
EM
310
300
304
V_{SSEL}

FIG. 3B

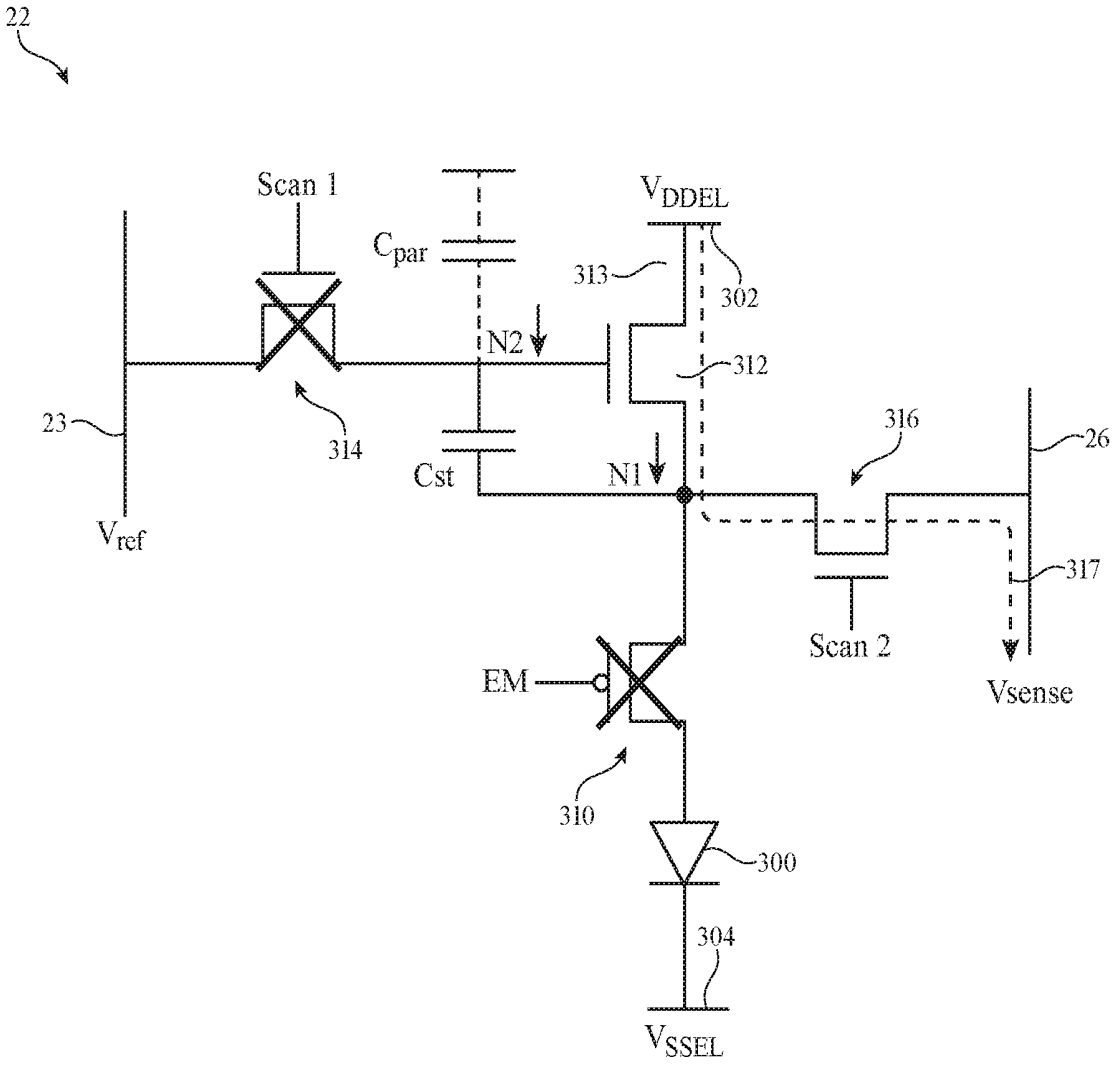

22
Scan 1
C_{par}
V_{DDEL}
313
302
N2
312
23
314
316
26
Cst
N1
V_{ref}
317
Scan 2
EM
Vsense
310
300
304
V_{SSEL}

FIG. 3C

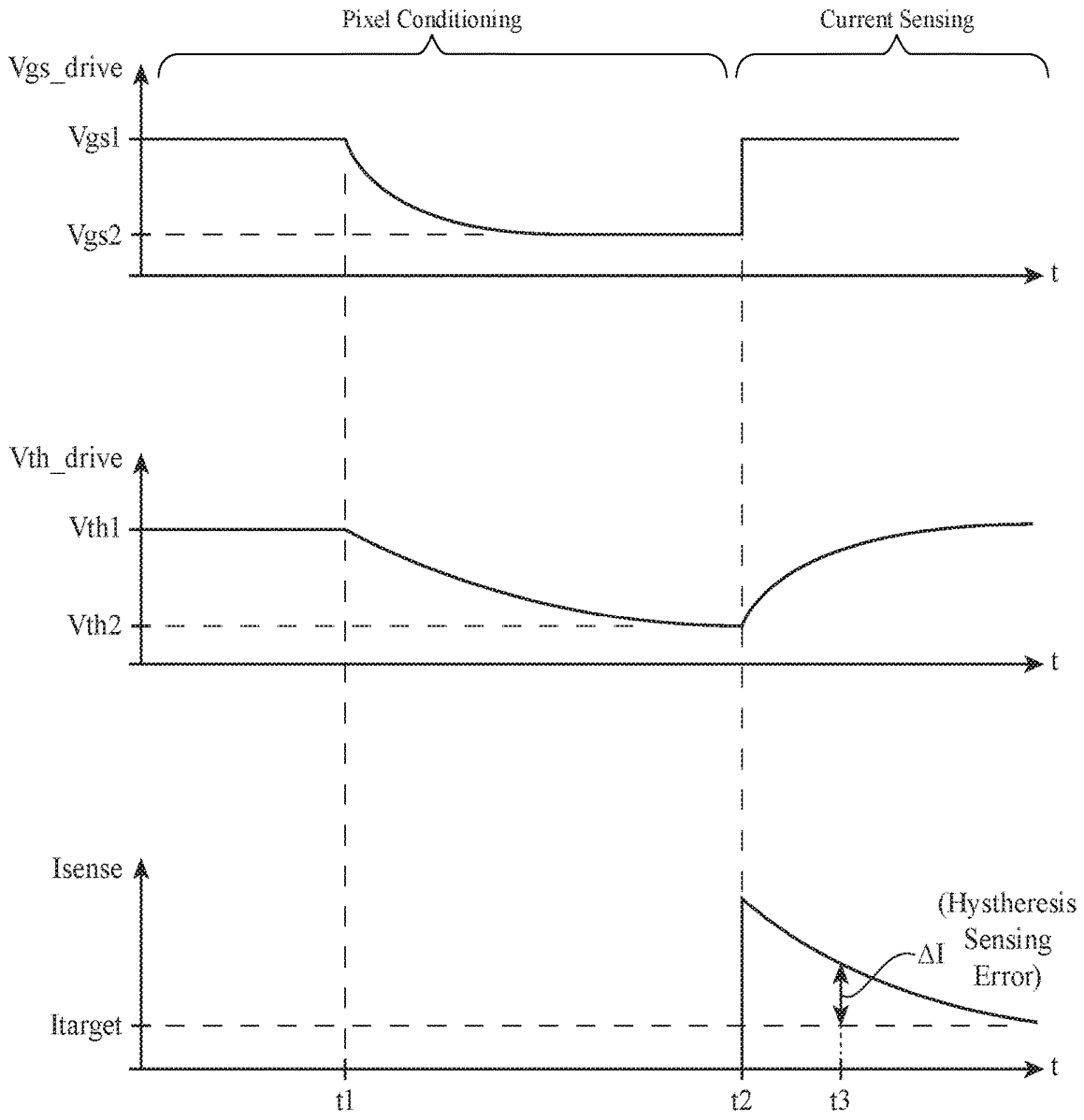

Pixel Conditioning
Current Sensing
Vgs_drive
Vgs1
Vgs2
t
Vth_drive
Vth1
Vth2
t
Isense
(Hystheresis Sensing Error)
ΔI
Itarget
t
t1
t2
t3

FIG. 4

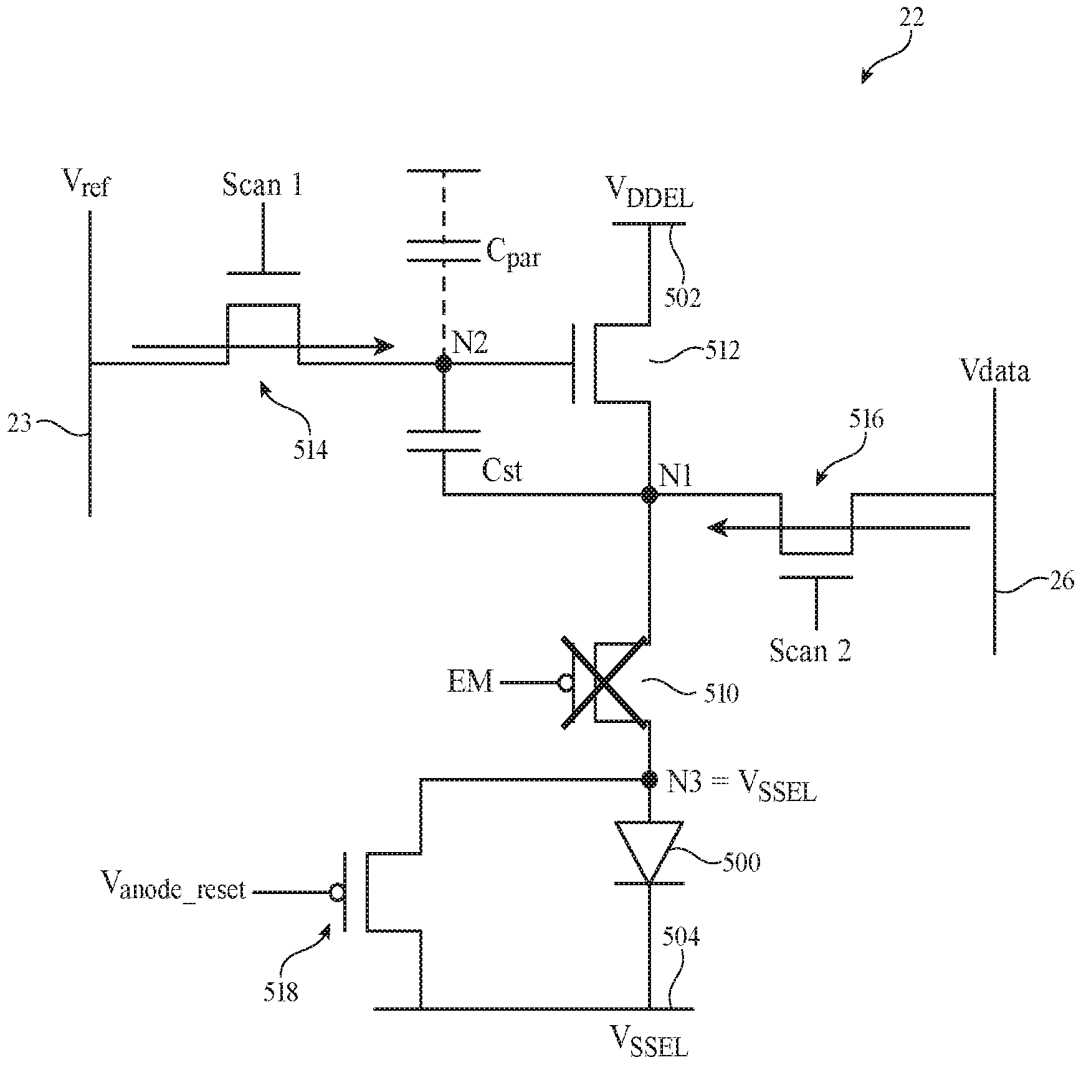

22
Vref
Scan 1
Cpar
VDDEL
502
N2
512
Vdata
23
514
516
Cst
N1
26
Scan 2
EM
510
N3 = VSSEL
500
Vanode_reset
504
518
VSSEL

FIG. 5A

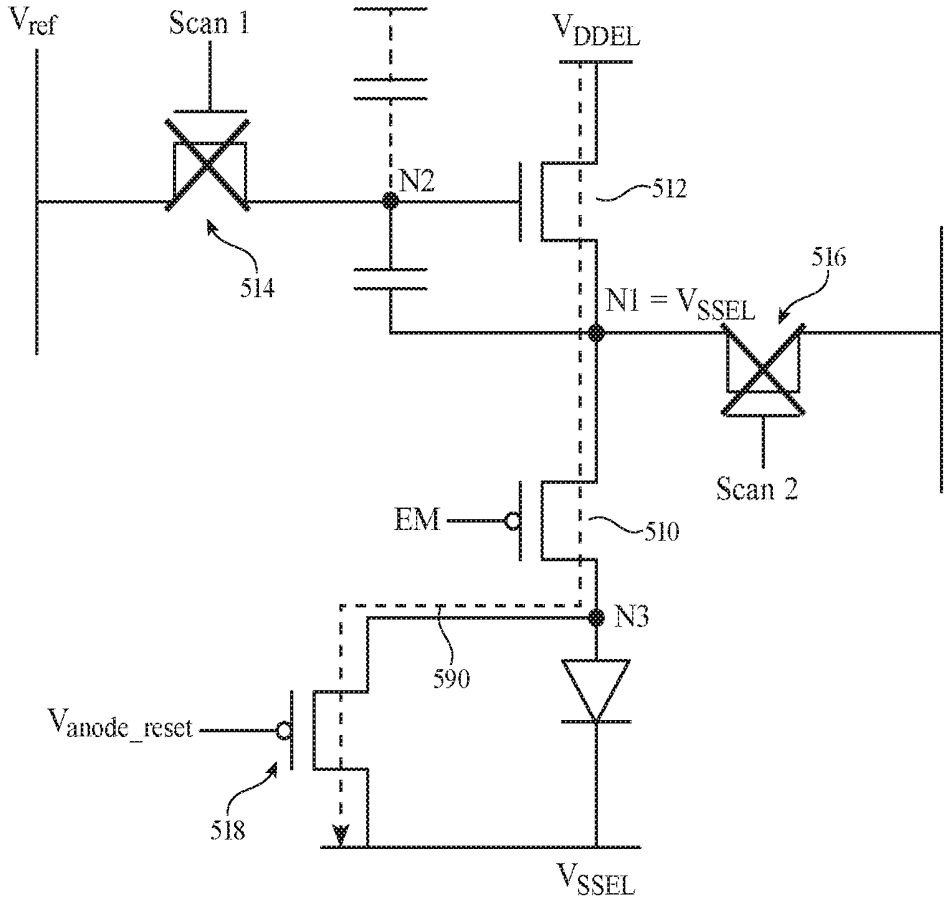

Vref
Scan 1
VDDEL
N2
512
514
516
N1 = VSSEL
Scan 2
EM
510
N3
590
Vanode_reset
518
VSSEL

FIG. 5B

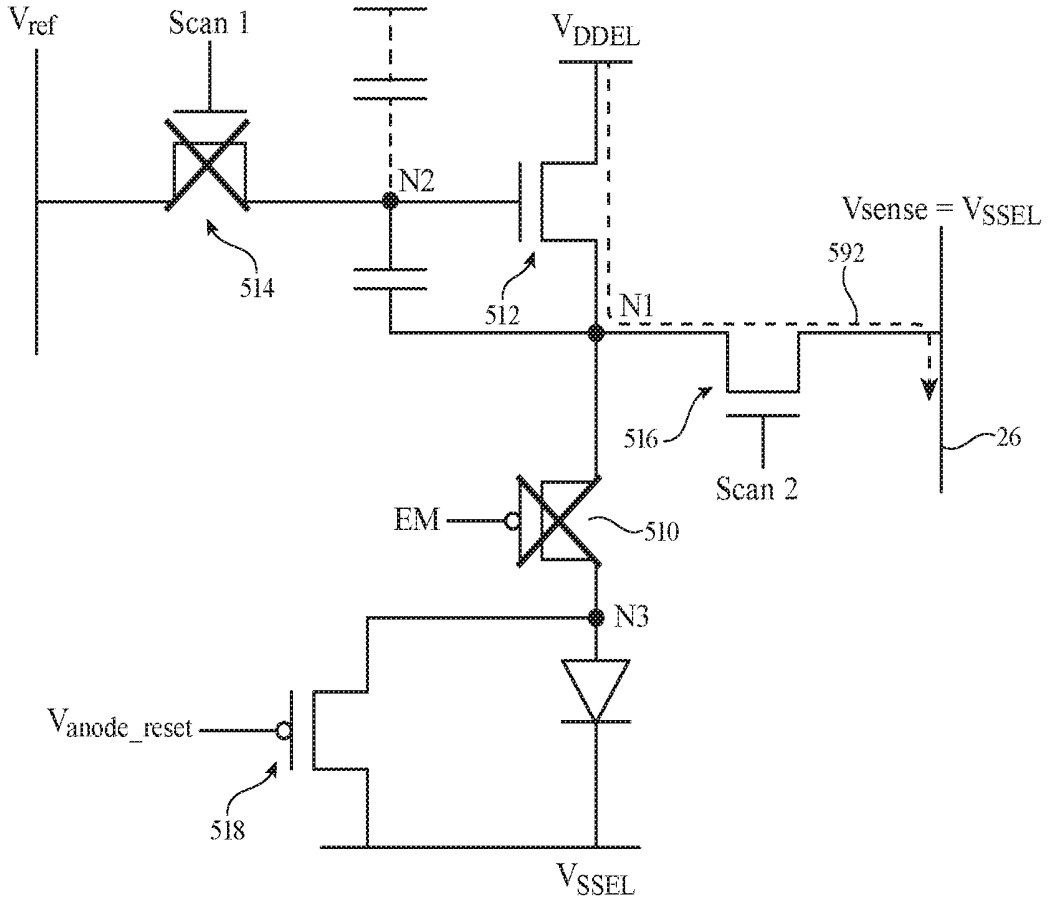

Vref
Scan 1
VDDEL
N2
514
512
N1
592
Vsense = VSSEL
516
Scan 2
26
EM
510
N3
Vanode_reset
518
VSSEL

FIG. 5C

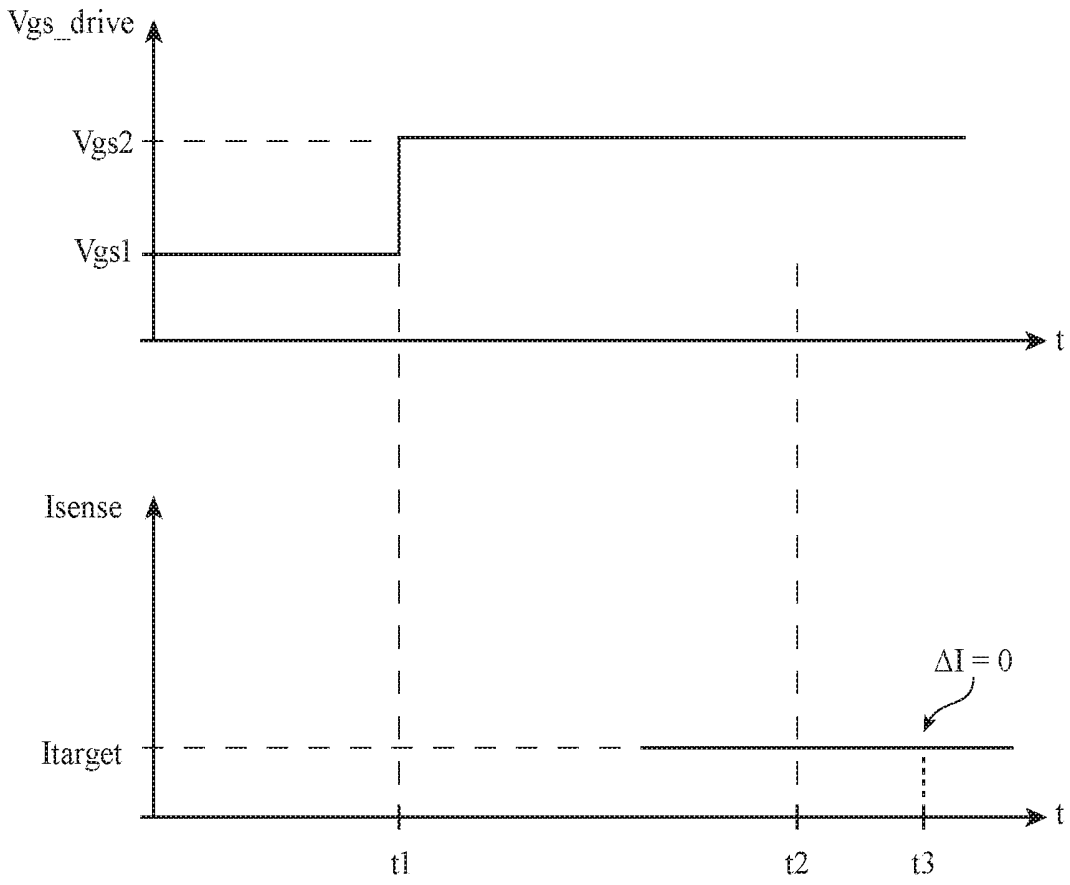


FIG. 6

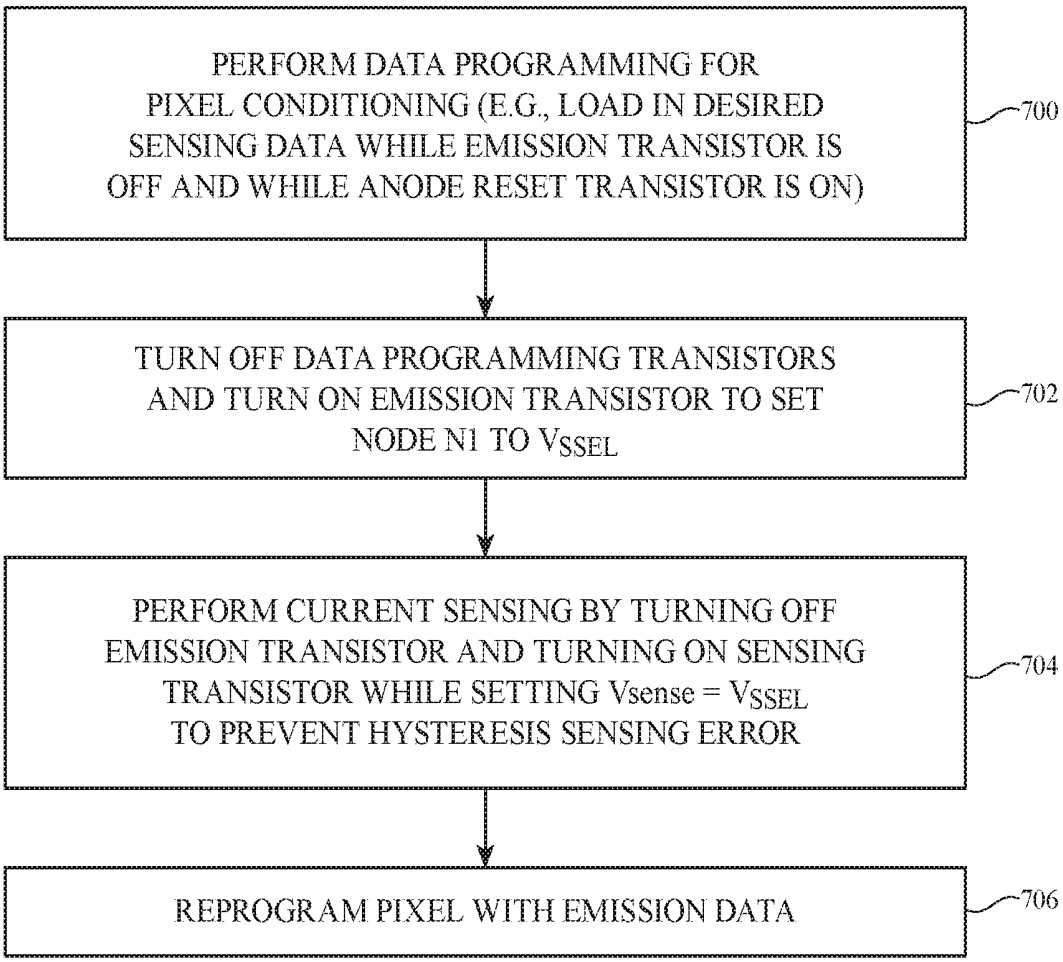

PERFORM DATA PROGRAMMING FOR PIXEL CONDITIONING (E.G., LOAD IN DESIRED SENSING DATA WHILE EMISSION TRANSISTOR IS OFF AND WHILE ANODE RESET TRANSISTOR IS ON)
700
TURN OFF DATA PROGRAMMING TRANSISTORS AND TURN ON EMISSION TRANSISTOR TO SET NODE N1 TO V_{SSEL}
702
PERFORM CURRENT SENSING BY TURNING OFF EMISSION TRANSISTOR AND TURNING ON SENSING TRANSISTOR WHILE SETTING Vsense = V_{SSEL} TO PREVENT HYSTERESIS SENSING ERROR
704
REPROGRAM PIXEL WITH EMISSION DATA
706

FIG. 7

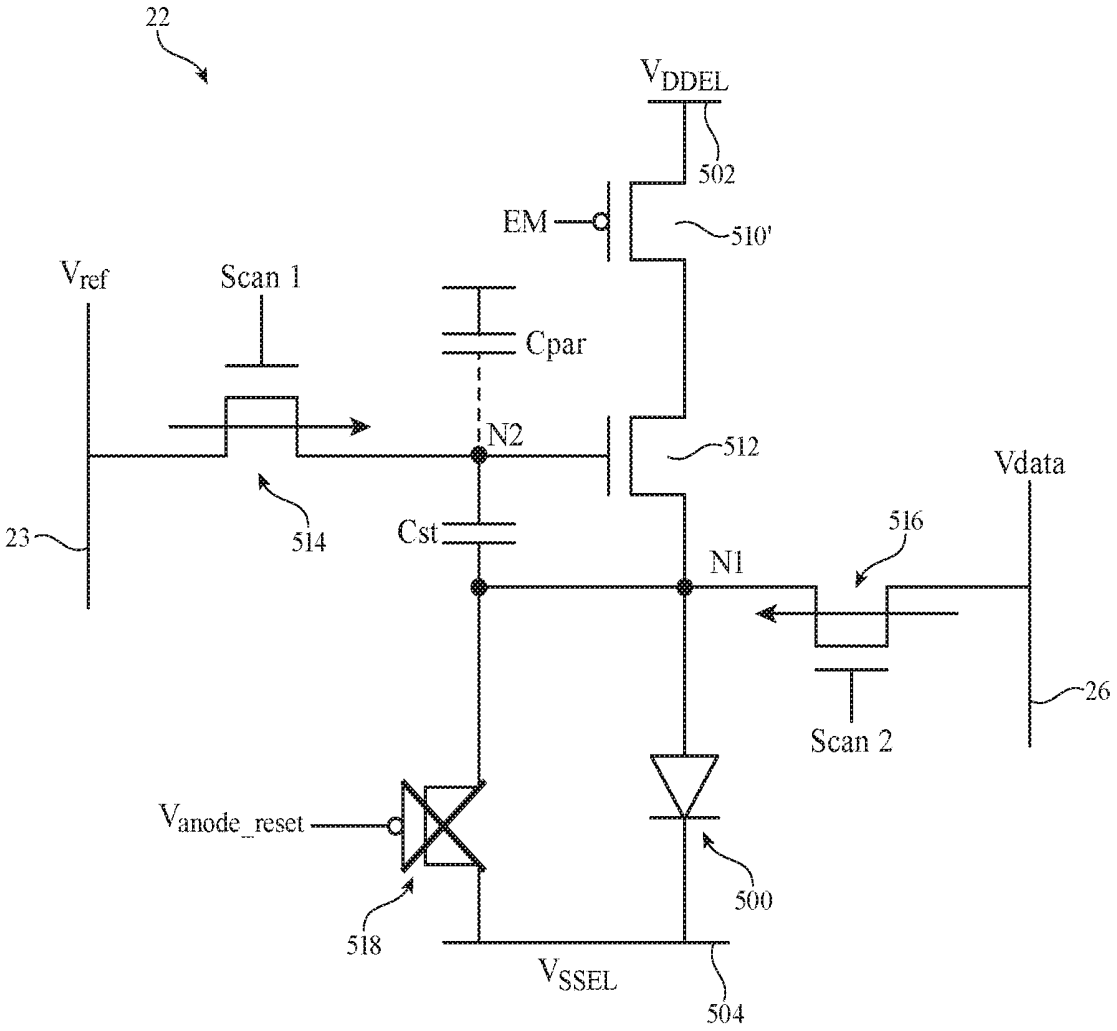

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
N2
512
Vdata
23
514
Cst
516
N1
26
Scan 2
V_{anode_reset}
500
518
V_{SSEL}
504

FIG. 8A

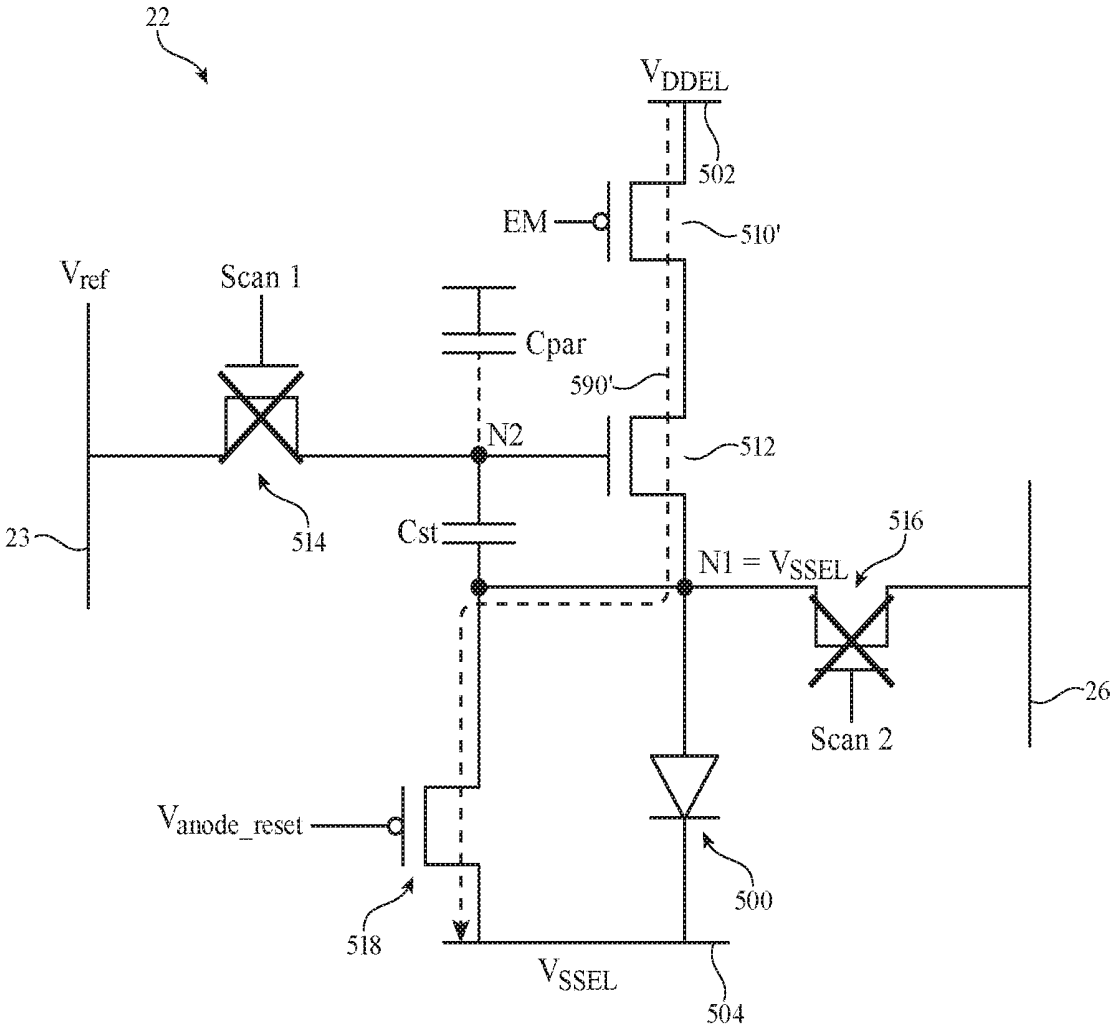

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
590'
N2
512
23
514
Cst
516
N1 = V_{SSEL}
26
Scan 2
V_{anode_reset}
500
518
V_{SSEL}
504

FIG. 8B

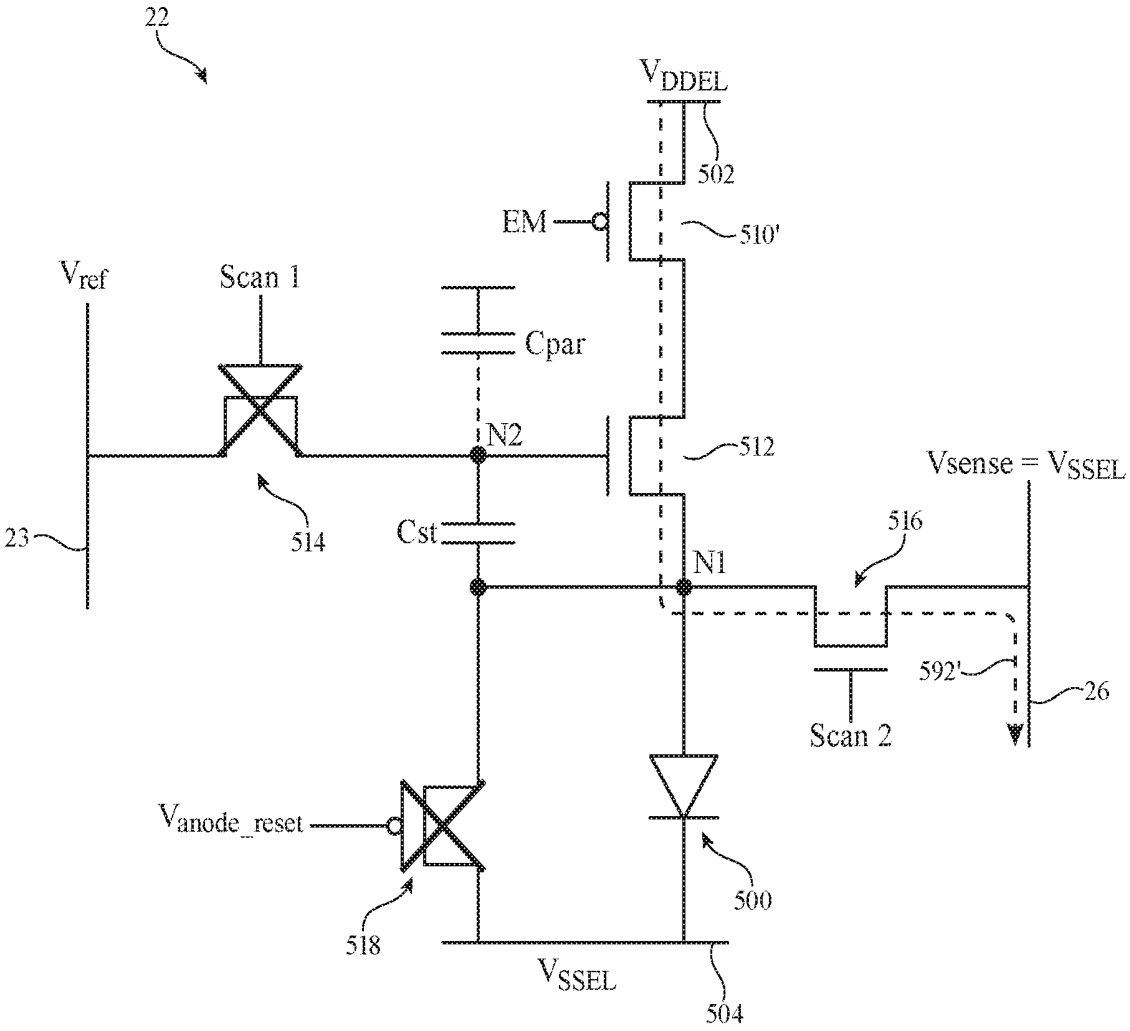

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
N2
512
Vsense = V_{SSEL}
23
514
Cst
N1
516
592'
26
Scan 2
V_{anode_reset}
500
518
V_{SSEL}
504

FIG. 8C

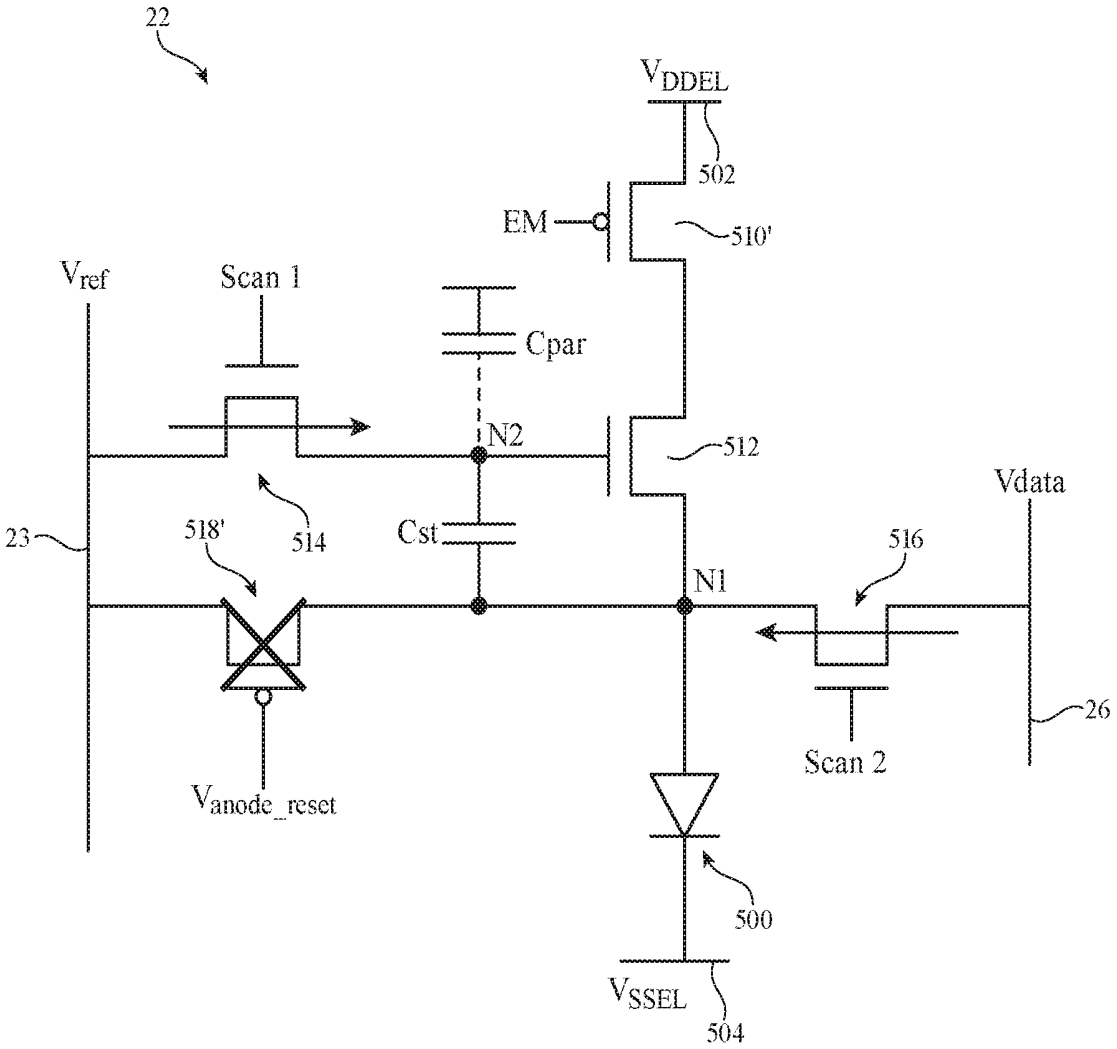

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
N2
512
Vdata
23
518'
514
Cst
516
N1
26
Scan 2
V_{anode_reset}
500
V_{SSEL}
504

FIG. 9A

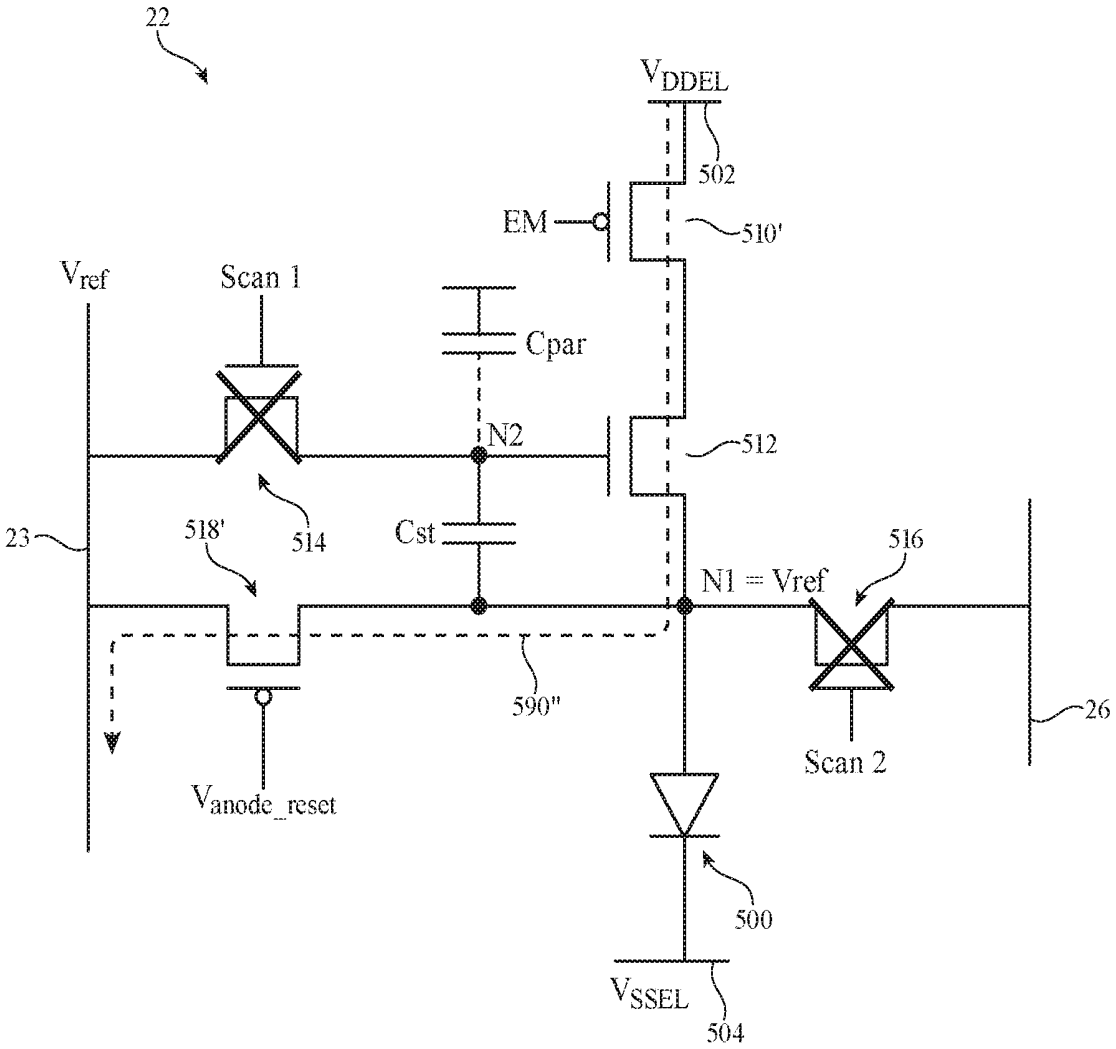

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
N2
512
23
518'
514
Cst
516
N1 = Vref
590"
26
Scan 2
V_{anode_reset}
500
V_{SSEL}
504

FIG. 9B

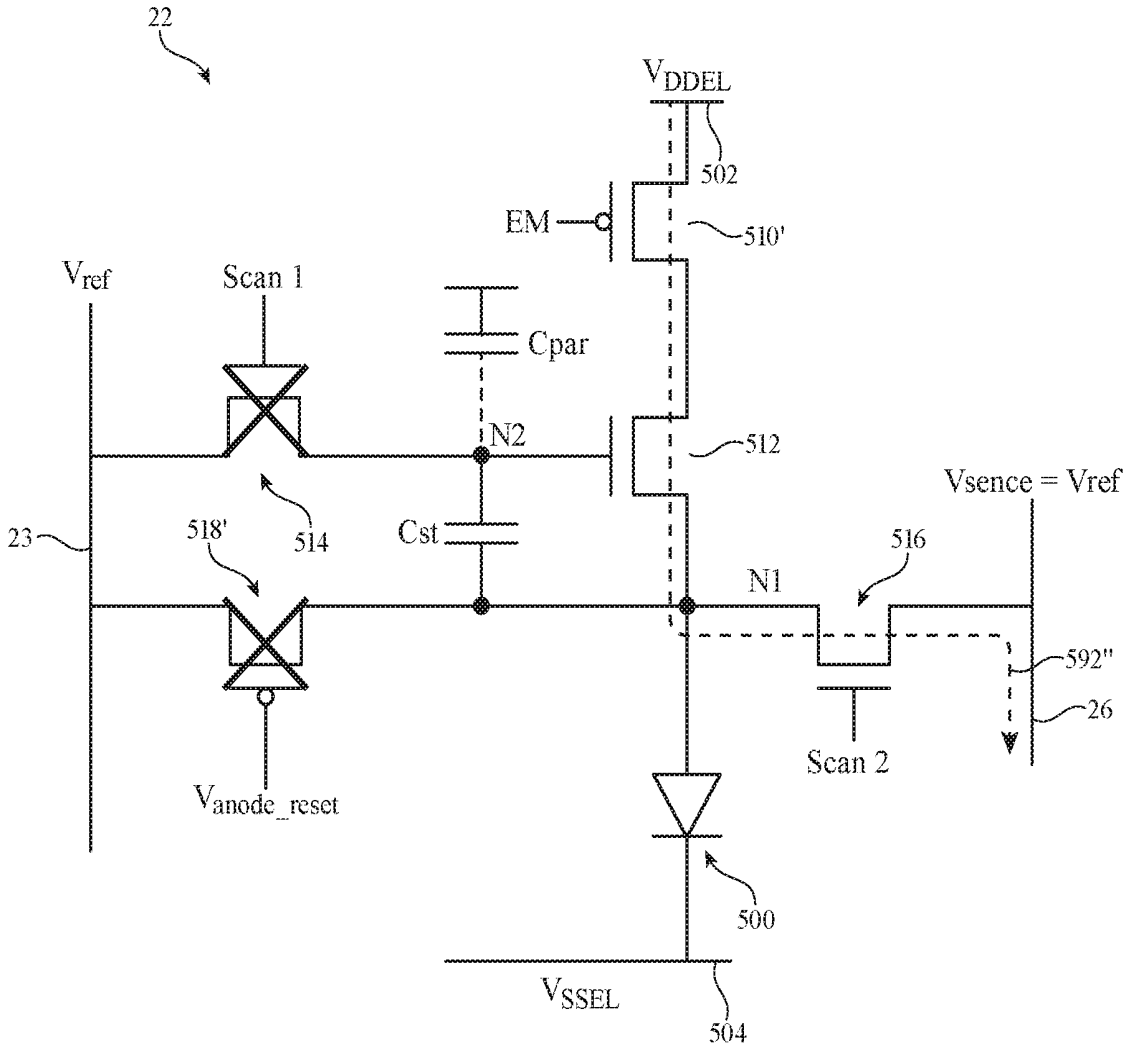

22
V_{DDEL}
502
EM
510'
V_{ref}
Scan 1
Cpar
N2
512
Vsence = Vref
23
518'
514
Cst
516
N1
592"
26
Scan 2
V_{anode_reset}
500
V_{SSEL}
504

FIG. 9C

METHODS AND APPARATUS FOR MITIGATING HYSTERESIS IMPACT ON CURRENT SENSING ACCURACY FOR AN ELECTRONIC DISPLAY

[0001] This application claims the benefit of provisional patent application No. 62/716,290, filed Aug. 8, 2018, which is hereby incorporated by reference herein in its entirety.

BACKGROUND

[0002] This relates generally to electronic devices with displays and, more particularly, to display driver circuitry for displays such as organic-light-emitting diode displays.

[0003] Electronic devices often include displays. For example, cellular telephones and portable computers include displays for presenting information to users.

[0004] Displays such as organic light-emitting diode displays have an array of display pixels based on light-emitting diodes. In this type of display, each display pixel includes a light-emitting diode and thin-film transistors for controlling application of a signal to the light-emitting diode to produce light.

[0005] An organic light-emitting diode display pixel includes a drive thin-film transistor connected to a data line via an access thin-film transistor. The access transistor may have a gate terminal that receives a scan signal via a corresponding scan line. Image data on the data line can be loaded into the display pixel by asserting the scan signal to turn on the access transistor. The display pixel includes a current source transistor that provides current to the organic light-emitting diode to produce light.

[0006] Transistors in an organic light-emitting diode display pixel may be subject to process, voltage, and temperature (PVT) variations. Due to such variations, transistor threshold voltages between different display pixels may vary. Variations in transistor threshold voltages can cause the display pixels to produce amounts of light that do not match a desired image. Compensation schemes are sometimes used to compensate for variations in threshold voltage. Such compensation schemes typically involve sampling operations that are performed within each pixel during normal display operations and thus increase the time required to display images.

[0007] It is within this context that the embodiments herein arise.

SUMMARY

[0008] An electronic device may include a display having an array of display pixels. The display pixels may be organic light-emitting diode display pixels. Each display pixel may have an organic light-emitting diode that emits light. A drive transistor (i.e., a current source transistor) in each display pixel may apply current to the organic light-emitting diode in that display pixel. The drive transistor may be characterized by a threshold voltage that is subject to random variations. Compensation circuitry may be used to measure sensing current from the drive transistor, to compare the sensing current to a predetermined current level, and to apply external compensation to the display pixel based on the comparison.

[0009] The display pixel may include an organic light-emitting diode, a drive transistor coupled in series with the organic light-emitting diode, an anode reset transistor directly coupled to the anode of the organic light-emitting diode, a data line, and a current sensing transistor coupled between the data line and the source terminal of the drive transistor. The anode reset transistor may be configured to drive the source terminal of the drive transistor to a given voltage during pixel conditioning operations. The current sensing transistor may be configured to output sensing current onto the data line during current sensing operations while the data line is biased to the given voltage to reduce hysteresis-induced current sensing error.

[0010] In one suitable arrangement, the given voltage is identical to the power supply voltage that is received directly at the cathode of the organic light-emitting diode. In this arrangement, the anode reset transistor has a source terminal coupled to the anode of the organic light-emitting diode and a drain terminal coupled to the cathode of the organic light-emitting diode. In another suitable arrangement, the give voltage is identical to the reference voltage that is supplied on a column reference voltage line. In this arrangement, the anode reset transistor has a source terminal coupled to the reference voltage line and a drain terminal coupled to the anode of the organic light-emitting diode. Configured in these ways, the voltage at the source terminal of the drive transistor remains unperturbed when the display pixel transitions from the pixel conditioning operations to the current sensing operations, thus eliminating hysteresis-induced current sensing error.

BRIEF DESCRIPTION OF THE DRAWINGS

[0011] FIG. **1** is a diagram of an illustrative electronic device having a display in accordance with an embodiment.

[0012] FIG. **2** is a diagram of an illustrative display having an array of organic light-emitting diode display pixels coupled to compensation circuitry in accordance with an embodiment.

[0013] FIG. **3**A shows a first snapshot of a given display pixel that is being programmed with sensing data during pixel conditioning operations.

[0014] FIG. **3**B shows a second snapshot of the given display pixel during pixel conditioning operations.

[0015] FIG. **3**C shows a third snapshot of the given display pixel during current sensing operations.

[0016] FIG. **4** is a timing diagram illustrating how the given display pixel shown in FIGS. **3**A-**3**C can suffer from hysteresis-induced current sensing error.

[0017] FIGS. **5**A-**5**C show different snapshots of an illustrative display pixel having an anode reset transistor configured to eliminate any hysteresis-induced current sensing error in accordance with an embodiment.

[0018] FIG. **6** is a timing diagram illustrating how the illustrative display pixel shown in FIG. **5**A-**5**C exhibits no current sensing error from hysteresis in accordance with an embodiment.

[0019] FIG. **7** is a flow chart of illustrative steps for operating the display pixel of FIGS. **5**A-**5**C in accordance with an embodiment.

[0020] FIGS. **8**A-**8**C show different snapshots of another suitable display pixel having an anode reset transistor configured to eliminate hysteresis-induced current sensing error in accordance with an embodiment.

[0021] FIGS. **9**A-**9**C show different snapshots of another suitable display pixel having an anode reset transistor configured to eliminate hysteresis-induced current sensing error in accordance with an embodiment.

DETAILED DESCRIPTION

[0022] An illustrative electronic device of the type that may be provided with an organic light-emitting diode (OLED) display is shown in FIG. **1**. As shown in FIG. **1**, electronic device **10** may have control circuitry **16**. Control circuitry **16** may include storage and processing circuitry for supporting the operation of device **10**. The storage and processing circuitry may include storage such as hard disk drive storage, nonvolatile memory (e.g., flash memory or other electrically-programmable-read-only memory configured to form a solid-state drive), volatile memory (e.g., static or dynamic random-access-memory), etc. Processing circuitry in control circuitry **16** may be used to control the operation of device **10**. The processing circuitry may be based on one or more microprocessors, microcontrollers, digital signal processors, baseband processors, power management units, audio codec chips, application specific integrated circuits, programmable integrated circuits, etc.

[0023] Input-output circuitry in device **10** such as input-output devices **12** may be used to allow data to be supplied to device **10** and to allow data to be provided from device **10** to external devices. Input-output devices **12** may include buttons, joysticks, click wheels, scrolling wheels, touch pads, key pads, keyboards, microphones, speakers, tone generators, vibrators, cameras, sensors, light-emitting diodes and other status indicators, data ports, etc. A user can control the operation of device **10** by supplying commands through input-output devices **12** and may receive status information and other output from device **10** using the output resources of input-output devices **12**.

[0024] Input-output devices **12** may include one or more displays such as display **14**. Display **14** may be a touch screen display that includes a touch sensor for gathering touch input from a user or display **14** may be insensitive to touch. A touch sensor for display **14** may be based on an array of capacitive touch sensor electrodes, acoustic touch sensor structures, resistive touch components, force-based touch sensor structures, a light-based touch sensor, or other suitable touch sensor arrangements.

[0025] Control circuitry **16** may be used to run software on device **10** such as operating system code and applications. During operation of device **10**, the software running on control circuitry **16** may display images on display **14** in input-output devices.

[0026] FIG. **2** shows display **14** and associated display driver circuitry **15**. Display **14** includes structures formed on one or more layers such as substrate **24**. Layers such as substrate **24** may be formed from planar rectangular layers of material such as planar glass layers. Display **14** may have an array of display pixels **22** for displaying images to a user. The array of display pixels **22** may be formed from rows and columns of display pixel structures on substrate **24**. These structures may include thin-film transistors such as polysilicon thin-film transistors, semiconducting oxide thin-film transistors, etc. There may be any suitable number of rows and columns in the array of display pixels **22** (e.g., ten or more, one hundred or more, or one thousand or more).

[0027] Display driver circuitry such as display driver integrated circuit **15** may be coupled to conductive paths such as metal traces on substrate **24** using solder or conductive adhesive. If desired, display driver integrated circuit **15** may be coupled to substrate **24** over a path such as a flexible printed circuit or other cable. Display driver integrated circuit **15** (sometimes referred to as a timing controller chip) may contain communications circuitry for communicating with system control circuitry **16** over path **125**. Path **125** may be formed from traces on a flexible printed circuit or other cable. Control circuitry **16** (see FIG. **1**) may be located on a main logic board in an electronic device such as a cellular telephone, computer, television, set-top box, media player, portable electronic device, or other electronic equipment in which display **14** is being used.

[0028] During operation, the control circuitry may supply display driver integrated circuit **15** with information on images to be displayed on display **14**. To display the images on display pixels **22**, display driver integrated circuit **15** may supply clock signals and other control signals to display driver circuitry such as row driver circuitry **18** and column driver circuitry **20**. For example, data circuitry **13** may receive image data and process the image data to provide pixel data signals to display **14**. The pixel data signals may be demultiplexed by column driver circuitry **20** and pixel data signals D may be routed to each pixel **22** over data lines **26** (e.g., to each red, green, or blue pixel). Row driver circuitry **18** and/or column driver circuitry **20** may be formed from one or more integrated circuits and/or one or more thin-film transistor circuits.

[0029] Display driver integrated circuit **15** may include compensation circuitry **17** that helps to compensate for variations among display pixels **22** such as threshold voltage variations. Compensation circuitry **17** may, if desired, also help compensate for transistor aging. Compensation circuitry **17** may be coupled to pixels **22** via path **19**, switching circuitry **21**, and paths **23**. Compensation circuitry **17** may include sense circuitry **25** and bias circuitry **27**. Sense circuitry **25** may be used in sensing (e.g., sampling) voltages from pixels **22**. During sense operations, switching circuitry **21** may be configured to electrically couple sense circuitry **25** to one or more selected pixels **22**. For example, compensation circuitry **17** may produce control signal CTL to configure switching circuitry **21**. Sense circuitry **25** may sample currents, voltages or other desired signals from the pixels over path **19**, switching circuitry **21**, and paths **23**. Bias circuitry **27** may include one or more driver circuits for driving reference or bias voltages onto nodes of pixels **22**. For example, switching circuitry **21** may be configured to electrically couple path **19** to one or more selected pixels **22**. In this scenario, bias circuitry **27** may provide reference signals to the selected pixels. The reference signals may bias nodes at the selected pixels at desired voltages for the sensing operations performed by sense circuitry **25**.

[0030] Compensation circuitry **17** may perform compensation operations on pixels **22** using bias circuitry **27** and sense circuitry **25** to generate compensation data that is stored in storage **29**. Storage **29** may, for example, be static random-access memory (SRAM). In the example of FIG. **2**, storage **29** is on-chip storage. If desired, storage **29** may be off-chip storage such as non-volatile storage (e.g., non-volatile memory that maintains stored information even when the display is powered off). The compensation data stored in storage **29** may be retrieved by data circuitry **13** during display operations. Data circuitry **13** may process the compensation data along with incoming digital image data to generate compensated data signals for pixels **22**.

[0031] Data circuitry **13** may include gamma circuitry **44** that provides a mapping of digital image data to analog data signals at appropriate voltage levels for driving pixels **22**. Multiplexer **46** receives a set of possible analog data signals

from gamma circuitry **44** and is controlled by the digital image data to select an appropriate analog data signal for the digital image data. Compensation data retrieved from storage **29** may be added to (or subtracted from) the digital image data by adder circuit **48** to help compensate for transistor variations (e.g., threshold voltage variations, transistor aging variations, or other types of variations) between different display pixels **22**. This example in which compensation data is added as an offset to digital input image data is merely illustrative. In general, data circuitry **13** may process compensation data along with image data to produce compensated analog data signals for driving pixels **22**.

[0032] In contrast to techniques that focus on performing in-pixel threshold canceling (such as by performing a reset phase followed by a threshold compensation phase), performing sensing and compensation in this way using compensation circuitry **17** outside of each pixel **22** allows for higher refresh rates (e.g., greater than 60 Hz refresh rate, at least 120 Hz refresh rate, etc.) and is sometimes referred to as "external" compensation. External variation compensation may be performed in the factory, in real time (e.g., during blanking intervals between successive image frames), or when the display is idle (as examples).

[0033] Row driver circuitry **18** may be located on the left and right edges of display **14**, on only a single edge of display **14**, or elsewhere in display **14**. During operation, row driver circuitry **18** may provide row control signals on horizontal lines **28** (sometimes referred to as row lines, "scan" lines, and/or "emission" lines). Row driver circuitry **18** may include scan line driver circuitry for driving the scan lines and emission line driver circuitry for driving the emission lines.

[0034] Demultiplexing circuitry **20** may be used to provide data signals D from display driver integrated circuit (DIC) **15** onto a plurality of corresponding vertical lines **26**. Demultiplexing circuitry **20** may sometimes be referred to as column driver circuitry, data line driver circuitry, or source driver circuitry. Vertical lines **26** are sometimes referred to as data lines. During display operations, display data may be loaded into display pixels **22** using lines **26**.

[0035] Each data line **26** is associated with a respective column of display pixels **22**. Sets of horizontal signal lines **28** run horizontally across display **14**. Each set of horizontal signal lines **28** is associated with a respective row of display pixels **22**. The number of horizontal signal lines in each row is determined by the number of transistors in the display pixels **22** that are being controlled independently by the horizontal signal lines. Display pixels of different configurations may be operated by different numbers of scan lines.

[0036] Row driver circuitry **18** may assert control signals such as scan and emission signals on the row lines **28** in display **14**. For example, driver circuitry **18** may receive clock signals and other control signals from display driver integrated circuit **15** and may, in response to the received signals, assert scan control signals and an emission control signal in each row of display pixels **22**. Rows of display pixels **22** may be processed in sequence, with processing for each frame of image data starting at the top of the array of display pixels and ending at the bottom of the array (as an example). While the scan lines in a row are being asserted, control signals and data signals that are provided to column driver circuitry **20** by DIC **15** may direct column driver circuitry **20** to demultiplex and drive associated data signals D (e.g., compensated data signals provided by data circuitry **13**) onto data lines **26** so that the display pixels in the row will be programmed with the display data appearing on the data lines D. The display pixels can then display the loaded display data.

[0037] The external pixel compensation scheme described above may involve using sense circuitry **25** to perform current sensing on selected display pixels. In general, the amount of emission current flowing through each display pixel is dependent on the threshold voltage of a "drive" thin-film transistor within that display pixel. The threshold voltage of the drive transistor may also vary depending on the current value of the gate-to-source voltage Vgs of the drive transistor. For example, the drive transistor threshold voltage may exhibit a first average level when Vgs is being raised from low to high, but may exhibit a second average level that is different than the first average level when Vgs is being lowered from high to low, thus yielding different current-voltage (I-V) characteristic curves. This dependence of the threshold voltage on the actual Vgs value is sometimes referred to as transistor "hysteresis," and if care is not taken, this hysteresis can negatively impact the accuracy of the current sensing operations performing by circuitry **25**.

[0038] FIGS. **3**A-**3**C show different snapshots of a display pixel **22** that might suffer from hysteresis-induced error during pixel conditioning and current sensing operations. As shown in FIG. **3**A, pixel **22** includes an organic light-emitting diode (OLED) **300**, n-channel thin-film transistors **312**, **314**, and **316**, p-channel thin-film transistor **310**, and storage capacitor Cst. In particular, transistor **312** is sometimes referred to as the "drive" transistor since the amount of voltage stored across the gate and source terminals of transistor **312** determines the amount of current that is allowed to flow through diode **300**.

[0039] Transistors **312** and **310** and diode **300** may be coupled in series between a first power supply line **302** (e.g., a positive power supply line on which positive power supply voltage VDDEL is provided) and a second power supply line **304** (e.g., a ground power supply line on which ground voltage VSSEL is provided). Transistor **310** has a gate terminal that receives an emission control signal EM provided over an emission control line. Transistor **310** is therefore sometimes referred to as an emission control transistor. Storage capacitor Cst may have first and second terminals that are coupled to the gate and source terminals of drive transistor **312**, respectively. Additional parasitic capacitance that is coupled to the gate terminal of transistor **312** is lumped together and collectively represented as capacitance Cpar in FIG. **3**A.

[0040] Transistor **314** may be coupled between column line **23** (e.g., a shared path on which a reference voltage Vref is provided to each pixel **22** along a given column) and the gate terminal of drive transistor **312**. The gate terminal of drive transistor **312** is marked as node N**2**. Transistor **314** has a gate terminal that receives a first scan control signal Scan**1** via a first scan control line and is selectively turned on to set the gate voltage of drive transistor **312** to a predetermined voltage level (e.g., to voltage level Vref). Transistor **314** is therefore sometimes referred to as a gate voltage setting transistor.

[0041] Transistor **316** may be coupled between column line **26** (e.g., a data line that is coupled to column driver circuitry **20**) and the source terminal of drive transistor **312**. The source terminal of drive transistor **312** is marked as node N**1**. Transistor **316** has a gate terminal that receives a

second scan control signal Scan2 via a second scan control line and is selectively turned on to load a data signal into pixel 22. Transistor 316 is therefore sometimes referred to as a data loading transistor.

[0042] Prior to sensing, display pixel 22 has to be first pre-conditioned with the desired data value. FIG. 3A illustrates the first phase of pixel conditioning during which sensing data is programmed into pixel 22 (i.e., the data programming phase of pixel conditioning operations). During this phase, emission transistor 310 is turned off by deasserting emission control signal EM (i.e., by driving EM high since transistor 310 is active low) while transistor 314 is turned on to bias node N2 to voltage level Vref (i.e., by asserting scan control signal Scan1) and while transistor 316 is turned on to bias node N1 to load data voltage Vdata onto node N1 (i.e., by asserting scan control signal Scan2). Configured in this way, a certain amount of voltage is stored across the gate and source terminals of transistor 312 across capacitor Cst.

[0043] FIG. 3B illustrates the second phase of pixel conditioning during which transistors 314 and 316 are turned off (i.e., by deasserting scan control signals Scan1 and Scan2), and pixel 22 just waits for a certain amount of time to let the voltages stabilize within that pixel before sensing. As shown in FIG. 3B, when transistors 310, 314, and 316 are all turned off, current will flow through drive transistor 312 to charge node N1 towards positive power supply voltage VDDEL (as indicated by current path 313). As a result, the voltage at node N1 will increase by a first amount. Since the voltage across capacitor Cst has nowhere to discharge at this time, node N2 will also be pushed upwards. Due to the existence of parasitic capacitance Cpar at node N2 (which acts like a capacitive divider), however, the amount of voltage increase at node N2 will be relatively less than that of node N1. The net result is that the gate-to-source voltage Vgs of drive transistor 312 will actually decrease during this time period after transistors 314 and 316 are shut off.

[0044] Pixel conditioning operations will then be followed by current sensing operations (see, FIG. 3C). During sensing operations, transistor 316 will be turned on by asserting scan control signal Scan2 (e.g., by temporarily pulsing Scan2 high). During this time, a sensing voltage Vsense will be applied onto data line 26 (e.g., using bias circuitry 27 of FIG. 2), and a current will flow through transistors 312 and 316 as indicated by current path 312. Assuming Vsense is less than VDDEL (which is generally the case), turning on transistor 316 would cause node N1 is discharge towards Vsense. As a result, the voltage at node N1 will decrease by a third amount. Since the voltage across capacitor Cst still has nowhere to discharge at this time, node N2 will also be pushed downwards. Due to the existence of parasitic capacitance Cpar at node N2 (which acts like a capacitive divider), however, the amount of voltage decrease at node N2 will be relatively less than that of node N1. The net result is that the gate-to-source voltage Vgs of drive transistor 312 will actually increase during this time period after transistor 316 is switched on.

[0045] FIG. 4 is a timing diagram illustrating how pixel 22 shown in FIGS. 3A-3C can suffer from hysteresis-induced current sensing error. Prior to time t1 (which corresponding to the first phase of the pixel conditional operations shown in FIG. 3A), transistors 314 and 316 are turned on to charge the gate-to-source voltage of the drive transistor Vgs_drive to a first voltage level Vgs1.

[0046] At time t1 (which correspond to the second phase of the pixel conditioning operations shown in FIG. 3B), transistors 314 and 316 are turned off, which effectively reduces Vgs_drive to a second voltage level Vgs2, as described above in connection with FIG. 3B. Changing gate-to-source voltage Vgs will also affect the threshold voltage of the drive transistor Vth_drive. As shown in the middle plot of FIG. 4, the drive transistor threshold voltage Vth_drive may fall from a first threshold voltage level Vth1 at time t1 to a second threshold voltage level Vth2 at time t2.

[0047] At time t2 (which corresponds to the end of pixel conditioning and the start of current sensing operations), transistor 316 is turned on to discharge node N1 to Vsense. Assuming Vsense is less than VDDEL (which is generally the case), which effectively pushes Vgs_drive to back up towards Vgs1, as described above in connection with FIG. 3C. Even though Vgs_drive can change quickly (as shown in the top plot of FIG. 4), the drive transistor threshold voltage Vth_drive is not able to adjust so abruptly (as shown in the middle plot of FIG. 4 immediately following time t2). As a result, the current being sensed through line 26 will deviate substantially from the target current level Itarget (as shown in the bottom plot of FIG. 4). Assuming current sensing measurements are taken soon after at time t3, there will still be a certain amount of current sensing error ΔI induced by this hysteresis. Hysteresis-induced sensing error can negatively impact the accuracy of current sensing operations and therefore the efficacy of the external compensation scheme performed by compensation circuitry 17 (FIG. 2).

[0048] In accordance with an embodiment, display pixel 22 may be provided with an anode reset transistor that is continuously turned on during pixel conditioning and current sensing operations to help mitigate the impacts of hysteresis. FIGS. 5A-5C show different snapshots of an illustrative display pixel 22 having an anode reset transistor 518 configured to eliminate hysteresis-induced current sensing error. As shown in FIG. 5A, pixel 22 includes an organic light-emitting diode (OLED) 500, n-channel thin-film transistors 512, 514, and 516, p-channel thin-film transistors 510 and 518, and storage capacitor Cst. Transistor 512 is sometimes referred to as the "drive" transistor since the amount of voltage stored across the gate and source terminals of transistor 512 determines the amount of current that is allowed to flow through OLED 500.

[0049] Transistors 512 and 510 and diode 500 may be coupled in series between a first power supply line 502 (e.g., a positive power supply line on which positive power supply voltage VDDEL is provided) and a second power supply line 504 (e.g., a ground power supply line on which ground voltage VSSEL is provided). Diode 500 has a cathode terminal coupled to power supply line 504 and an anode terminal coupled to node N3. Transistor 510 has a gate terminal that receives an emission control signal EM provided over an emission control line. Transistor 510 is therefore sometimes referred to as an emission control transistor or an emission transistor. Storage capacitor Cst may have a first terminal coupled to the gate terminal of drive transistor 512 and a second terminal coupled to the source terminal of drive transistor 512. Additional parasitic capacitance that is present at the gate terminal of transistor 512 is lumped together and collectively represented as capacitance Cpar in FIG. 5A.

[0050] Transistor **514** has a drain terminal coupled to column line **23** (e.g., a shared path on which a reference voltage Vref is provided to each pixel **22** along a given column) and a source terminal coupled to the gate terminal of drive transistor **512**. The gate terminal of drive transistor **512** is labeled as node N2. Transistor **514** has a gate terminal that receives a first scan control signal Scan**1** via a first scan control line and is selectively turned on by asserting signal Scan**1** to set the gate voltage of drive transistor **312** to a predetermined voltage level (e.g., to voltage level Vref). Transistor **514** is therefore sometimes referred to as a gate voltage setting transistor.

[0051] Transistor **516** has a drain terminal coupled to column line **26** (e.g., a data line that is coupled to column driver circuitry **20**) and a source terminal coupled to the source terminal of drive transistor **512**. The source terminal of drive transistor **312** is labeled as node N1. Transistor **516** has a gate terminal that receives a second scan control signal Scan**2** via a second scan control line and is selectively turned on by asserting signal Scan**2** to load a data signal into pixel **22**. Transistor **516** is therefore sometimes referred to as a data loading transistor.

[0052] The anode terminal of diode **500** is labeled as node N3. In particular, transistor **518** has a source terminal coupled to node N3, a drain terminal coupled to power supply line **504**, and a gate terminal configured to receive anode reset control signal Vanode_reset. Since transistor **518** is a p-channel transistor, transistor **518** may be turned on by asserting signal Vanode_reset (i.e., by driving Vanode_reset low). Transistor **518** is therefore sometimes referred to as the anode reset transistor. Anode reset transistor **518** may be constantly turned on during pixel conditioning and current sensing operations to prevent any hysteresis impact.

[0053] The example of FIG. **5**A in which thin-film transistors **510**, **512**, **514**, and **516** are implemented as n-channel or n-type transistors while thin-film transistors **510** and **518** are implemented as p-channel or p-type transistors is merely illustrative and is not intended to limit the scope of the present embodiments. If desired, at least some of the n-channel transistors may instead be implemented as p-channel transistors, at least some of the p-channel transistors may instead be implemented as n-channel transistors, all of the transistors within pixel **22** may be implemented using n-channel thin-film transistors, or all of the transistors within pixel **22** may be implemented using p-channel thin-film transistors. In yet other embodiments, pixel **22** may include more than one discrete capacitor component in additional to storage capacitor Cst.

[0054] Prior to sensing, display pixel **22** has to be first pre-conditioned with the desired data value, which can vary from a low or even negative voltage level below VSSEL to a high positive voltage level at or around VDDEL. FIG. **5**A illustrates a first phase of pixel conditioning during which a data voltage Vdata is loaded into pixel **22** (e.g., the data programming phase of pixel conditioning operations). During the data programming phase, emission transistor **510** is turned off by deasserting emission control signal EM (e.g., by driving EM high since transistor **510** is active low) while transistor **514** is turned on to bias node N2 to voltage level Vref (e.g., by asserting or pulsing high scan control signal Scan**1**) and while transistor **516** is turned on to bias node N1 to load data voltage Vdata onto node N1 (e.g., by asserting or pulsing high scan control signal Scan**2**). Operated in this way, a certain amount of voltage is stored across the gate and source terminals of transistor **512** across capacitor Cst. In this example, the gate-to-source voltage Vgs of drive transistor **512** may be equal to Vref minus Vdata.

[0055] In particular, note that anode reset transistor **518** is turned on during the first phase of pixel conditioning. Turning on anode reset transistor **518** during this time would drive node N3 to voltage VSSEL.

[0056] FIG. **5**B illustrates a second phase of pixel conditioning during which transistors **514** and **516** are turned off (i.e., by deasserting or driving low both scan control signals Scan**1** and Scan**2**). In contrast to the example of FIG. **3**B, however, emission transistor **510** is turned on by asserting or driving low emission control signal EM. Since anode reset transistor **518** remains on during the entirety of the pixel conditioning operations, current is allowed to flow through transistors **512**, **510**, and **518** as indicated by current path **590**. Configured in this way, transistors **510** and **518** may pull node N1 down to VSSEL (e.g., node N1 may be driven to VSSEL by the end of the pixel conditioning operations).

[0057] Assuming VSSEL is less than Vdata, the voltage at node N1 may decrease by a first amount. Since the voltage across capacitor Cst has nowhere to discharge at this time, node N2 will also be pushed downwards. Due to the existence of parasitic capacitance Cpar at node N2 (which acts like a capacitive divider), however, the amount of voltage decrease at node N2 will be relatively less than that of node N1. The net result is that the gate-to-source voltage Vgs of drive transistor **312** will actually increase during this time period after transistors **514** and **516** are shut off.

[0058] Pixel conditioning operations will then be followed by current sensing operations (see, e.g., FIG. **5**C). During sensing operations, emission transistor **510** is turned off by deasserting or driving high emission control signal EM, and transistor **516** will be turned on by asserting scan control signal Scan**2** (e.g., by temporarily pulsing Scan**2** high). Anode reset transistor **518** remains turned on during the current sensing phase, but this need not be the case. If desired, anode reset transistor **518** may also be turned off. During this time, a sensing voltage Vsense will be applied onto data line **26** (e.g., using bias circuitry **27** of FIG. **2**), and a current will flow through transistors **512** and **516** as indicated by current path **592**. Transistor **516** is therefore sometimes referred to as a current sensing transistor.

[0059] In particular, the sensing voltage Vsense may be set equal to voltage VSSEL (i.e., Vsense=VSSEL). Biasing data line **26** to VSSEL during current sensing ensures that node N1 remains unchanged when pixel **22** transitions from pixel conditioning to current sensing operations since node N1 was previously biased to VSSEL as shown in FIG. **5**B. If node N1 remains unchanged when transistor **516** is turned on, the gate-to-source voltage Vgs of drive transistor **512** stays constant, so the threshold voltage of transistor **512** will also stay constant. As long as the threshold voltage of drive transistor **512** remains unperturbed, then there will be no hysteresis impact and the corresponding current **592** sensed through column **26** will be accurate (i.e., there will be no hysteresis-induced current sensing error).

[0060] FIG. **6** is a timing diagram illustrating how pixel **22** shown in FIGS. **5**A-**5**C exhibits no current sensing error from hysteresis. Prior to time t1 (which corresponding to the first phase of the pixel conditional operations shown in FIG. **5**A), transistors **514** and **516** are turned on to charge the gate-to-source voltage of the drive transistor Vgs_drive to a first voltage level Vgs**1**.

[0061] At time t1 (which correspond to the second phase of the pixel conditioning operations shown in FIG. **5**B), transistors **514** and **516** are turned off, and emission transistor **510** is turned on. During this time, transistors **510** and **518** pulls node N1 down to VSSEL, which effectively increases Vgs_drive to a second voltage level Vgs**2**, as described above in connection with FIG. **5**B.

[0062] At time t**2** (which corresponds to the end of pixel conditioning and the start of current sensing operations), emission transistor **510** is turned off while transistor **516** is turned on to apply the sensing voltage Vsense to node N**1**. Since Vsense is biased equal to VSSEL (as shown in FIG. **5**C), there is no voltage change at node N**1** since node N**1** was already previously driven to VSSEL by anode reset transistor **518**. Thus, at time t**2**, the gate-to-source voltage of the drive transistor Vgs_drive remains unperturbed at Vgs**2**. If Vgs_drive remains unchanged at time t**2**, the current being sensed through line **26** will remain fixed at the target current level Itarget (as shown in the bottom plot of FIG. **6**). Assuming current sensing measurements are taken soon after at time t**3**, there will be no hysteresis-induced current sensing error ΔI. Since sensing error ΔI is zero, the accuracy of current sensing operations and therefore the efficacy of the external compensation scheme performed by compensation circuitry **17** of FIG. **2** is dramatically improved.

[0063] FIG. **7** is a flow chart of illustrative steps for operating the display pixel of FIGS. **5**A-**5**C in accordance with an embodiment. At step **700**, display pixel **22** may be configured to perform the data programming phase for pixel conditioning. This is accomplished by turning on both transistors **514** and **516** while emission transistor **510** is turned off. Anode reset transistor **518** may be turned on during this period to drive node N**3** to power supply voltage VSSEL.

[0064] At step **702**, pixel **22** may be configured to perform the second phase of pixel conditioning, wherein transistors **514** and **516** are both turned off while emission transistor **510** is turned on. Since anode reset transistor **518** remains on during this time, transistors **510** and **518** may drive node N**1** to power supply voltage VSSEL.

[0065] At step **704**, pixel **22** may be configured to perform current sensing operations by turning off emission transistor **510** and turning on current sensing transistor **516** while setting the sensing voltage Vsense equal to VSSEL. Operated in this way, there will be no voltage change at node N**1**, and hysteresis sensing error is minimized. Subsequently, at step **706**, pixel **22** may be reprogrammed with emission data. In general, the pixel conditioning and current sensing operations shown in FIG. **7** can be performed in the factory, in real time (e.g., during blanking intervals between successive image frames), when the display is idle, periodically, aperiodically, when initiated by the user, or at other suitable intervals.

[0066] The exemplary pixel architectures shown in FIGS. **5**A-**5**C that include five transistors, one capacitor, one emission control line, and various scan control lines are merely illustrative. If desired, the techniques described herein may be extended or applied to pixel structures that include any number of semi-conducting oxide or silicon transistors, any number of capacitors, more than one emission line, fewer than two scan control lines or more than two scan control lines, and other suitable display pixel architectures.

[0067] The example of FIG. **5** in which the emission transistor **510** is interposed between drive transistor **512** and diode **500** and where anode reset transistor **518** is constantly turned on during pixel conditioning operations is merely illustrative. In another suitable arrangement, the emission transistor may instead be interposed between positive power supply terminal **502** and drive transistor **512** (see, e.g., FIG. **8**A). As shown in FIG. **8**A, emission transistor **510'** has a drain terminal coupled to power supply terminal **502** and a source terminal coupled to the drain terminal of drive transistor **512**. As a result, the source terminal of drive transistor (i.e., node N**1**) is directly connected to the anode of diode **500** and to the source terminal of anode reset transistor **518**. In other words, node N**1** and N**3** has collapsed or merged into a single node.

[0068] Prior to sensing, display pixel **22** has to be first pre-conditioned with the desired data value, which can vary from a low or even negative voltage level below VSSEL to a high positive voltage level at or around VDDEL. FIG. **8**A illustrates a first phase of pixel conditioning during which a data voltage Vdata is loaded into pixel **22** (e.g., the data programming phase of pixel conditioning operations). During the data programming phase, emission transistor **510'** is turned on by asserting emission control signal EM (e.g., by driving EM low since transistor **510'** is active low) to drive the drain terminal of drive transistor **512** to VDDEL while transistor **514** is turned on to bias node N**2** to voltage level Vref (e.g., by asserting or pulsing high scan control signal Scan**1**) and while transistor **516** is turned on to bias node N**1** to load data voltage Vdata onto node N**1** (e.g., by asserting or pulsing high scan control signal Scan**2**). Operated in this way, a certain amount of voltage is stored across the gate and source terminals of transistor **512** across capacitor Cst. In this example, the gate-to-source voltage Vgs of drive transistor **512** may be equal to Vref minus Vdata.

[0069] In particular, note that anode reset transistor **518** will have to be turned off during the first phase of pixel conditioning to allow Vdata to be loaded into node N**1**. Otherwise, anode reset transistor **518** will fight against transistor **516** to try to drive node N**1** towards VSSEL.

[0070] FIG. **8**B illustrates a second phase of pixel conditioning during which transistors **514** and **516** are turned off (i.e., by deasserting or driving low both scan control signals Scan**1** and Scan**2**). Emission transistor **510'** remains on during the second phase. Anode reset transistor **518** is now turned on by asserting or driving low signal Vanode_reset so that current is allowed to flow through transistors **510'**, **512**, and **518** as indicated by current path **590'**. Configured in this way, transistor **518** may pull node N**1** down to VSSEL (e.g., node N**1** may be driven to VSSEL by the end of the pixel conditioning operations).

[0071] Assuming VSSEL is less than Vdata, the voltage at node N**1** may decrease by a first amount. Since the voltage across capacitor Cst has nowhere to discharge at this time, node N**2** will also be pushed downwards. Due to the existence of parasitic capacitance Cpar at node N**2** (which acts like a capacitive divider), however, the amount of voltage decrease at node N**2** will be relatively less than that of node N**1**. The net result is that the gate-to-source voltage Vgs of drive transistor **312** will actually increase during this time period after transistors **514** and **516** are shut off.

[0072] Pixel conditioning operations will then be followed by current sensing operations (see, e.g., FIG. **8**C). During sensing operations, anode reset transistor **518** is turned off by deasserting or driving high signal Vanode_reset, and transistor **516** will be turned on by asserting scan control

signal Scan2 (e.g., by temporarily pulsing Scan2 high). During this time, a sensing voltage Vsense will be applied onto data line **26** (e.g., using bias circuitry **27** of FIG. **2**), and a current will flow through transistors **512** and **516** as indicated by current path **592'**. In particular, the sensing voltage Vsense may be set equal to voltage VSSEL (i.e., Vsense=VSSEL). Biasing data line **26** to VSSEL during current sensing ensures that node N1 remains unchanged when pixel **22** transitions from pixel conditioning to current sensing operations since node N1 was previously biased to VSSEL as shown in FIG. **8**B. If node N1 remains unchanged when transistor **516** is turned on, the gate-to-source voltage Vgs of drive transistor **512** stays constant, so the threshold voltage of transistor **512** will also stay constant. As long as the threshold voltage of drive transistor **512** remains unperturbed, then there will be no hysteresis impact and the corresponding current **592'** sensed through column **26** will be accurate (i.e., there will be no hysteresis-induced current sensing error). The resulting waveforms produced by pixel **22** of FIGS. **8**A-**8**C is identical to those already shown and described in connection with FIG. **6**.

[0073] The example of FIG. **8** in which the anode reset transistor is coupled between node N1 and power supply terminal **504** is merely illustrative. In yet another suitable arrangement, the anode reset transistor may instead be coupled between node N1 and column reference line **23** (see, e.g., FIG. **9**A). As shown in FIG. **9**A, anode reset transistor **518'** has a source terminal coupled to reference line **23** and a drain terminal coupled to node N1. Configured in this way, anode reset transistor **518'** may be configured to reset node N1 to reference voltage Vref instead of VSSEL.

[0074] Prior to sensing, display pixel **22** has to be first pre-conditioned with the desired data value, which can vary from a low or even negative voltage level below VSSEL to a high positive voltage level at or around VDDEL. FIG. **9**A illustrates a first phase of pixel conditioning during which a data voltage Vdata is loaded into pixel **22** (e.g., the data programming phase of pixel conditioning operations). During the data programming phase, emission transistor **510'** is turned on by asserting emission control signal EM (e.g., by driving EM low since transistor **510'** is active low) to drive the drain terminal of drive transistor **512** to VDDEL while transistor **514** is turned on to bias node N2 to voltage level Vref (e.g., by asserting or pulsing high scan control signal Scan1) and while transistor **516** is turned on to bias node N1 to load data voltage Vdata onto node N1 (e.g., by asserting or pulsing high scan control signal Scan2). Operated in this way, a certain amount of voltage is stored across the gate and source terminals of transistor **512** across capacitor Cst. In this example, the gate-to-source voltage Vgs of drive transistor **512** may be equal to Vref minus Vdata.

[0075] In particular, note that anode reset transistor **518'** will have to be turned off during the first phase of pixel conditioning to allow Vdata to be loaded into node N1. Otherwise, anode reset transistor **518'** will fight against transistor **516** to try to drive node N1 towards Vref.

[0076] FIG. **9**B illustrates a second phase of pixel conditioning during which transistors **514** and **516** are turned off (i.e., by deasserting or driving low both scan control signals Scan1 and Scan2). Emission transistor **510'** remains on during the second phase. Anode reset transistor **518'** is now turned on by asserting or driving low signal Vanode_reset so that current is allowed to flow through transistors **510'**, **512**, and **518'** as indicated by current path **590"**. Configured in this way, transistor **518'** may drive node N1 to Vref (e.g., node N1 may be driven to Vref by the end of the pixel conditioning operations).

[0077] Pixel conditioning operations will then be followed by current sensing operations (see, e.g., FIG. **9**C). During sensing operations, anode reset transistor **518'** is turned off by deasserting or driving high signal Vanode_reset, and transistor **516** will be turned on by asserting scan control signal Scan2 (e.g., by temporarily pulsing Scan2 high). During this time, a sensing voltage Vsense will be applied onto data line **26** (e.g., using bias circuitry **27** of FIG. **2**), and a current will flow through transistors **512** and **516** as indicated by current path **592"**. In particular, the sensing voltage Vsense may be set equal to voltage Vref (i.e., Vsense=Vref). Biasing data line **26** to Vref during current sensing ensures that node N1 remains unchanged when pixel **22** transitions from pixel conditioning to current sensing operations since node N1 was previously biased to Vref as shown in FIG. **9**B. If node N1 remains unchanged when transistor **516** is turned on, the gate-to-source voltage Vgs of drive transistor **512** stays constant, so the threshold voltage of transistor **512** will also stay constant. As long as the threshold voltage of drive transistor **512** remains unperturbed, then there will be no hysteresis impact and the corresponding current **592"** sensed through column **26** will be accurate (i.e., there will be no hysteresis-induced current sensing error). The resulting waveforms produced by pixel **22** of FIGS. **9**A-**9**C is identical to those already shown and described in connection with FIG. **6**.

[0078] The foregoing is merely illustrative and various modifications can be made by those skilled in the art without departing from the scope and spirit of the described embodiments. The foregoing embodiments may be implemented individually or in any combination.

What is claimed is:

1. A display pixel, comprising:
- an organic light-emitting diode having an anode and a cathode;
- a drive transistor coupled in series with the organic light-emitting diode, wherein the drive transistor has a drain terminal, a gate terminal, and a source terminal;
- an anode reset transistor directly coupled to the anode of the organic light-emitting diode, wherein the anode reset transistor is configured to drive the source terminal of the drive transistor to a given voltage during pixel conditioning operations;
- a data line; and
- a current sensing transistor coupled between the data line and the source terminal of the drive transistor, wherein the current sensing transistor is configured to output sensing current onto the data line during current sensing operations while the data line is biased to the given voltage to reduce hysteresis-induced current sensing error.

2. The display pixel of claim **1**, wherein the voltage at the source terminal of the drive transistor remains unperturbed when the display pixel transitions from the pixel conditioning operations to the current sensing operations.

3. The display pixel of claim **1**, further comprising a storage capacitor coupled across the gate and source terminals of the drive transistor.

4. The display pixel of claim **1**, further comprising:
- a power supply line directly connected to the cathode of the organic light-emitting diode, wherein the power

supply line is biased at the given voltage, and wherein the anode reset transistor has a source terminal coupled to the anode of the organic light-emitting diode and a drain terminal coupled to the cathode of the organic light-emitting diode.

5. The display pixel of claim **4**, further comprising:

an emission transistor coupled in series with the drive transistor and the organic light-emitting diode, wherein the emission transistor has a gate terminal configured to receive an emission control signal, and wherein the emission transistor is turned on while the anode reset transistor is configured to drive the source terminal of the drive transistor to the given voltage during the pixel conditioning operations.

6. The display pixel of claim **5**, wherein the emission transistor is turned off during a portion of the pixel condition operations when data is loaded into the display pixel, and wherein the emission transistor is also turned off during the current sensing operations.

7. The display pixel of claim **5**, wherein the emission transistor is turned on during a portion of the pixel condition operations when data is loaded into the display pixel, and wherein the emission transistor is also turned on during the current sensing operations.

8. The display pixel of claim **1**, further comprising:

a reference voltage line, wherein the reference voltage line is biased at the given voltage; and

a gate setting transistor having a drain terminal coupled to the reference voltage line, a source terminal directly coupled to the gate terminal of the drive transistor, and a gate terminal configured to receive a scan control signal, wherein the anode reset transistor has a source terminal coupled to the reference voltage line and a drain terminal coupled to the anode of the organic light-emitting diode.

9. The display pixel of claim **8**, further comprising:

an emission transistor coupled in series with the drive transistor and the organic light-emitting diode, wherein the emission transistor has a gate terminal configured to receive an emission control signal, and wherein the emission transistor is turned on while the anode reset transistor is configured to drive the source terminal of the drive transistor to the given voltage during the pixel conditioning operations.

10. The display pixel of claim **9**, wherein the gate setting transistor is turned on while the anode resetting transistor is turned off during a portion of the pixel condition operations when data is loaded into the display pixel, and wherein the gate setting transistor and the anode reset transistor are turned off during the current sensing operations.

11. A method of operating a display pixel that comprises a drive transistor and an organic light-emitting diode coupled in series with the drive transistor, the method comprising:

during pixel conditioning operations, using an anode reset transistor in the display pixel to drive a source terminal of the drive transistor to a given voltage; and

during current sensing operations that immediately follow the pixel conditioning operations, using a current sensing transistor to output a sensing current onto a data line while biasing the data line to the given voltage to reduce hysteresis-induced current sensing error.

12. The method of claim **11**, further comprising:

ensuring that the voltage at the source terminal of the drive transistor does not change when the current sensing transistor is turned on at the onset of the current sensing operations.

13. The method of claim **12**, wherein the organic light-emitting diode has a cathode that is directly connected to a power supply line that is biased to the given voltage.

14. The method of claim **12**, wherein the display pixel further comprises a reference voltage line and a gate setting transistor coupled between the reference voltage line and a gate terminal of the drive transistor, and wherein the reference voltage line is biased to the given voltage level.

15. The method of claim **12**, wherein the display pixel further comprises an emission transistor connected in series with the drive transistor and the organic light-emitting diode, the method further comprising:

turning on the emission transistor while the anode reset transistor is used to drive the source terminal of the drive transistor to the given voltage.

16. An electronic device, comprising:

control circuitry; and

a display coupled to the control circuitry, wherein the display comprises:

an organic light-emitting diode; and

a drive transistor coupled in series with the organic light-emitting diode, wherein the drive transistor has a gate-to-source voltage that is biased to a given voltage level during pixel conditioning operations, and wherein the gate-to-source voltage of the drive transistor remains unperturbed at the start of current sensing operations immediately following the pixel conditioning operations to eliminate hysteresis-induced current sensing error.

17. The electronic device of claim **16**, wherein the display further comprises:

an anode reset transistor configured to drive a source terminal of the drive transistor to a given power supply voltage level during the pixel conditioning operations.

18. The electronic device of claim **17**, wherein the display further comprises:

a data loading transistor configured to output a sensing current to a corresponding data line during the current sensing operations, wherein the data line is biased to the given power supply voltage during the current sensing operations.

19. The electronic device of claim **18**, wherein the anode reset transistor is directly connected to an anode of the organic light-emitting diode, wherein the anode reset transistor is always turned on during the pixel conditioning operations.

20. The electronic device of claim **18**, wherein the anode reset transistor is directly connected to a reference voltage line on which a reference voltage is provided.

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专利名称(译)	于电子显示器的减轻磁滞对电流感测精度的影响的方法和设备		
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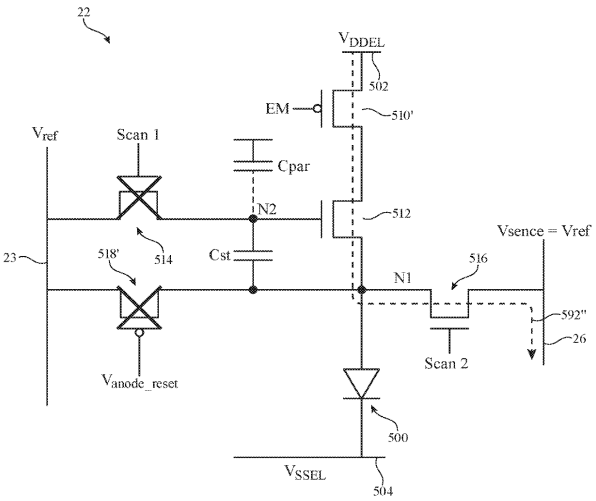
显示器可以包括有机发光二极管显示像素的阵列，该有机发光二极管显示像素的阵列具有以经受晶体管变化的阈值电压为特征的晶体管。 补偿电路可用于从选定的显示像素感测电流。 显示像素可以包括驱动晶体管，用于将参考电压驱动到驱动晶体管的栅极端子上的栅极设置晶体管，用于将驱动晶体管连接到数据/电流感测线的数据加载和电流感测晶体管，光。 发光二极管，耦合在驱动晶体管和二极管之间的发射控制晶体管以及用于选择性地重置二极管的阳极端子的阳极重置晶体管。 在像素调节和电流感测操作期间，阳极复位晶体管可以不断导通，以确保驱动晶体管的源极端没有电压扰动，这可以帮助防止磁滞引起的电流感测误差。